

# HP ProLiant DL120 G7 Server

## Maintenance and Service Guide

### **Abstract**

This document is for an experienced service technician. It is helpful if you are qualified in the servicing of computer equipment and trained in recognizing hazards in products with hazardous energy levels and are familiar with weight and stability precautions for rack installations.



Part Number: 638026-004  
September 2012  
Edition: 4

© Copyright 2011, 2012 Hewlett-Packard Development Company, L.P.

The information contained herein is subject to change without notice. The only warranties for HP products and services are set forth in the express warranty statements accompanying such products and services. Nothing herein should be construed as constituting an additional warranty. HP shall not be liable for technical or editorial errors or omissions contained herein.

Microsoft® and Windows® are U.S. registered trademarks of Microsoft Corporation.

Intel®, Intel® Xeon®, Pentium®, and Celeron® are trademarks of Intel Corporation in the U.S. and other countries.

---

# Contents

<b>Customer self repair .....</b>	<b>5</b>
Parts only warranty service .....	5
<b>Illustrated parts catalog .....</b>	<b>15</b>
Mechanical components.....	15
System components .....	18
<b>Removal and replacement procedures .....</b>	<b>23</b>
Required tools.....	23
Safety considerations.....	23
Preventing electrostatic discharge .....	23
Server warnings and cautions .....	23
Preparation procedures .....	24
Power down the server .....	24
Remove the server from the rack .....	24
Access panel .....	25
Air baffle .....	25
PCIe riser cage .....	26
PCIe riser board .....	27
Drive blank.....	28
Hot-plug drive .....	28
Redundant hot-plug power supply.....	29
Redundant hot-plug power supply backplane .....	30
Nonredundant power supply bracket.....	31
Nonredundant power supply .....	32
Optical drive .....	33
Fan .....	35
Expansion board.....	35
Drive cage .....	36
Battery-backed write cache procedures .....	37
BBWC module .....	37
BBWC battery pack .....	38
Recovering data from the battery-backed write cache .....	39
System battery .....	40
HP Trusted Platform Module .....	41
Heatsink.....	41
Processor .....	43
DIMM .....	47
System board .....	48
<b>Cabling .....</b>	<b>55</b>
Cabling overview .....	55
Server cabling .....	55
Nonredundant power supply cabling .....	55
Redundant power supply cabling .....	56
Internal USB cabling .....	56
BBWC battery cabling .....	57

Optical drive cabling .....	58
SATA cabling .....	58
SAS cabling .....	59
<b>Diagnostic tools .....</b>	<b>61</b>
HP Insight Diagnostics .....	61
Integrated Management Log .....	61
HP Insight Remote Support software .....	61
USB support .....	62
<b>Server component identification .....</b>	<b>63</b>
Front panel components .....	63
Front panel LEDs .....	64
Rear panel components .....	64
Rear panel LEDs .....	65
PCIe expansion slot definitions .....	66
System board components .....	66
System board LEDs .....	67
System maintenance switch .....	67
NMI functionality .....	68
DIMM slot locations .....	68
SAS and SATA device numbering .....	69
SAS and SATA hard drive LEDs .....	69
BBWC module LEDs .....	70
Fan locations .....	71
T-10/T15 Torx screwdriver .....	72
<b>Specifications .....</b>	<b>73</b>
Environmental specifications .....	73
Mechanical specifications .....	73
Power supply specifications .....	73
Hot-plug power supply calculations .....	74
<b>Support and other resources .....</b>	<b>75</b>
Before you contact HP .....	75
HP contact information .....	75
<b>Acronyms and abbreviations .....</b>	<b>76</b>
<b>Documentation feedback .....</b>	<b>78</b>
<b>Index .....</b>	<b>79</b>

# Customer self repair

HP products are designed with many Customer Self Repair (CSR) parts to minimize repair time and allow for greater flexibility in performing defective parts replacement. If during the diagnosis period HP (or HP service providers or service partners) identifies that the repair can be accomplished by the use of a CSR part, HP will ship that part directly to you for replacement. There are two categories of CSR parts:

- **Mandatory**—Parts for which customer self repair is mandatory. If you request HP to replace these parts, you will be charged for the travel and labor costs of this service.
- **Optional**—Parts for which customer self repair is optional. These parts are also designed for customer self repair. If, however, you require that HP replace them for you, there may or may not be additional charges, depending on the type of warranty service designated for your product.

**NOTE:** Some HP parts are not designed for customer self repair. In order to satisfy the customer warranty, HP requires that an authorized service provider replace the part. These parts are identified as "No" in the Illustrated Parts Catalog.

Based on availability and where geography permits, CSR parts will be shipped for next business day delivery. Same day or four-hour delivery may be offered at an additional charge where geography permits. If assistance is required, you can call the HP Technical Support Center and a technician will help you over the telephone. HP specifies in the materials shipped with a replacement CSR part whether a defective part must be returned to HP. In cases where it is required to return the defective part to HP, you must ship the defective part back to HP within a defined period of time, normally five (5) business days. The defective part must be returned with the associated documentation in the provided shipping material. Failure to return the defective part may result in HP billing you for the replacement. With a customer self repair, HP will pay all shipping and part return costs and determine the courier/carrier to be used.

For more information about HP's Customer Self Repair program, contact your local service provider. For the North American program, refer to the HP website (<http://www.hp.com/go/selfrepair>).

## Parts only warranty service

Your HP Limited Warranty may include a parts only warranty service. Under the terms of parts only warranty service, HP will provide replacement parts free of charge.

For parts only warranty service, CSR part replacement is mandatory. If you request HP to replace these parts, you will be charged for the travel and labor costs of this service.

## Réparation par le client (CSR)

Les produits HP comportent de nombreuses pièces CSR (Customer Self Repair = réparation par le client) afin de minimiser les délais de réparation et faciliter le remplacement des pièces défectueuses. Si pendant la période de diagnostic, HP (ou ses partenaires ou mainteneurs agréés) détermine que la réparation peut être effectuée à l'aide d'une pièce CSR, HP vous l'envoie directement. Il existe deux catégories de pièces CSR:

Obligatoire - Pièces pour lesquelles la réparation par le client est obligatoire. Si vous demandez à HP de remplacer ces pièces, les coûts de déplacement et main d'œuvre du service vous seront facturés.

Facultatif - Pièces pour lesquelles la réparation par le client est facultative. Ces pièces sont également conçues pour permettre au client d'effectuer lui-même la réparation. Toutefois, si vous demandez à HP de remplacer ces pièces, l'intervention peut ou non vous être facturée, selon le type de garantie applicable à votre produit.

**REMARQUE:** Certaines pièces HP ne sont pas conçues pour permettre au client d'effectuer lui-même la réparation. Pour que la garantie puisse s'appliquer, HP exige que le remplacement de la pièce soit effectué par un Mainteneur Agréé. Ces pièces sont identifiées par la mention "Non" dans le Catalogue illustré.

Les pièces CSR sont livrées le jour ouvré suivant, dans la limite des stocks disponibles et selon votre situation géographique. Si votre situation géographique le permet et que vous demandez une livraison le jour même ou dans les 4 heures, celle-ci vous sera facturée. Pour bénéficier d'une assistance téléphonique,appelez le Centre d'assistance technique HP. Dans les documents envoyés avec la pièce de rechange CSR, HP précise s'il est nécessaire de lui retourner la pièce défectueuse. Si c'est le cas, vous devez le faire dans le délai indiqué, généralement cinq (5) jours ouvrés. La pièce et sa documentation doivent être retournées dans l'emballage fourni. Si vous ne retournez pas la pièce défectueuse, HP se réserve le droit de vous facturer les coûts de remplacement. Dans le cas d'une pièce CSR, HP supporte l'ensemble des frais d'expédition et de retour, et détermine la société de courses ou le transporteur à utiliser.

Pour plus d'informations sur le programme CSR de HP, contactez votre Mainteneur Agréé local. Pour plus d'informations sur ce programme en Amérique du Nord, consultez le site Web HP (<http://www.hp.com/go/selfrepair>).

## Service de garantie "pièces seules"

Votre garantie limitée HP peut inclure un service de garantie "pièces seules". Dans ce cas, les pièces de rechange fournies par HP ne sont pas facturées.

Dans le cadre de ce service, la réparation des pièces CSR par le client est obligatoire. Si vous demandez à HP de remplacer ces pièces, les coûts de déplacement et main d'œuvre du service vous seront facturés.

## Riparazione da parte del cliente

Per abbreviare i tempi di riparazione e garantire una maggiore flessibilità nella sostituzione di parti difettose, i prodotti HP sono realizzati con numerosi componenti che possono essere riparati direttamente dal cliente (CSR, Customer Self Repair). Se in fase di diagnostica HP (o un centro di servizi o di assistenza HP) identifica il guasto come riparabile mediante un ricambio CSR, HP lo spedirà direttamente al cliente per la sostituzione. Vi sono due categorie di parti CSR:

Obbligatorie – Parti che devono essere necessariamente riparate dal cliente. Se il cliente ne affida la riparazione ad HP, deve sostenere le spese di spedizione e di manodopera per il servizio.

Opzionali – Parti la cui riparazione da parte del cliente è facoltativa. Si tratta comunque di componenti progettati per questo scopo. Se tuttavia il cliente ne richiede la sostituzione ad HP, potrebbe dover sostenere spese addizionali a seconda del tipo di garanzia previsto per il prodotto.

**NOTA:** alcuni componenti HP non sono progettati per la riparazione da parte del cliente. Per rispettare la garanzia, HP richiede che queste parti siano sostituite da un centro di assistenza autorizzato. Tali parti sono identificate da un "No" nel Catalogo illustrato dei componenti.

In base alla disponibilità e alla località geografica, le parti CSR vengono spedite con consegna entro il giorno lavorativo seguente. La consegna nel giorno stesso o entro quattro ore è offerta con un supplemento di costo solo in alcune zone. In caso di necessità si può richiedere l'assistenza telefonica di un addetto del centro di supporto tecnico HP. Nel materiale fornito con una parte di ricambio CSR, HP specifica se il cliente deve restituire dei componenti. Qualora sia richiesta la resa ad HP del componente difettoso, lo si deve spedire ad HP entro un determinato periodo di tempo, generalmente cinque (5) giorni lavorativi. Il componente difettoso deve essere restituito con la documentazione associata nell'imballo di spedizione fornito. La mancata restituzione del componente può comportare la fatturazione del ricambio da parte di HP. Nel caso di riparazione da parte del cliente, HP sostiene tutte le spese di spedizione e resa e sceglie il corriere/vettore da utilizzare.

Per ulteriori informazioni sul programma CSR di HP contattare il centro di assistenza di zona. Per il programma in Nord America fare riferimento al sito Web HP (<http://www.hp.com/go/selfrepair>).

## Servizio di garanzia per i soli componenti

La garanzia limitata HP può includere un servizio di garanzia per i soli componenti. Nei termini di garanzia del servizio per i soli componenti, HP fornirà gratuitamente le parti di ricambio.

Per il servizio di garanzia per i soli componenti è obbligatoria la formula CSR che prevede la riparazione da parte del cliente. Se il cliente invece richiede la sostituzione ad HP, dovrà sostenere le spese di spedizione e di manodopera per il servizio.

## Customer Self Repair

HP Produkte enthalten viele CSR-Teile (Customer Self Repair), um Reparaturzeiten zu minimieren und höhere Flexibilität beim Austausch defekter Bauteile zu ermöglichen. Wenn HP (oder ein HP Servicepartner) bei der Diagnose feststellt, dass das Produkt mithilfe eines CSR-Teils repariert werden kann, sendet Ihnen HP dieses Bauteil zum Austausch direkt zu. CSR-Teile werden in zwei Kategorien unterteilt:

Zwingend – Teile, für die das Customer Self Repair-Verfahren zwingend vorgegeben ist. Wenn Sie den Austausch dieser Teile von HP vornehmen lassen, werden Ihnen die Anfahrt- und Arbeitskosten für diesen Service berechnet.

Optional – Teile, für die das Customer Self Repair-Verfahren optional ist. Diese Teile sind auch für Customer Self Repair ausgelegt. Wenn Sie jedoch den Austausch dieser Teile von HP vornehmen lassen möchten, können bei diesem Service je nach den für Ihr Produkt vorgesehenen Garantiebedingungen zusätzliche Kosten anfallen.

**HINWEIS:** Einige Teile sind nicht für Customer Self Repair ausgelegt. Um den Garantieanspruch des Kunden zu erfüllen, muss das Teil von einem HP Servicepartner ersetzt werden. Im illustrierten Teilekatalog sind diese Teile mit „No“ bzw. „Nein“ gekennzeichnet.

CSR-Teile werden abhängig von der Verfügbarkeit und vom Lieferziel am folgenden Geschäftstag geliefert. Für bestimmte Standorte ist eine Lieferung am selben Tag oder innerhalb von vier Stunden gegen einen Aufpreis verfügbar. Wenn Sie Hilfe benötigen, können Sie das HP technische Support Center anrufen und sich von einem Mitarbeiter per Telefon helfen lassen. Den Materialien, die mit einem CSR-Ersatzteil geliefert werden, können Sie entnehmen, ob das defekte Teil an HP zurückgeschickt werden muss. Wenn es erforderlich ist, das defekte Teil an HP zurückzuschicken, müssen Sie dies innerhalb eines vorgegebenen Zeitraums tun, in der Regel innerhalb von fünf (5) Geschäftstagen. Das defekte Teil muss mit der zugehörigen Dokumentation in der Verpackung zurückgeschickt werden, die im Lieferumfang enthalten ist. Wenn Sie das

defekte Teil nicht zurückschicken, kann HP Ihnen das Ersatzteil in Rechnung stellen. Im Falle von Customer Self Repair kommt HP für alle Kosten für die Lieferung und Rücksendung auf und bestimmt den Kurier-/Frachtdienst.

Weitere Informationen über das HP Customer Self Repair Programm erhalten Sie von Ihrem Servicepartner vor Ort. Informationen über das CSR-Programm in Nordamerika finden Sie auf der HP Website unter (<http://www.hp.com/go/selfrepair>).

## Parts-only Warranty Service (Garantieservice ausschließlich für Teile)

Ihre HP Garantie umfasst möglicherweise einen Parts-only Warranty Service (Garantieservice ausschließlich für Teile). Gemäß den Bestimmungen des Parts-only Warranty Service stellt HP Ersatzteile kostenlos zur Verfügung.

Für den Parts-only Warranty Service ist das CSR-Verfahren zwingend vorgegeben. Wenn Sie den Austausch dieser Teile von HP vornehmen lassen, werden Ihnen die Anfahrt- und Arbeitskosten für diesen Service berechnet.

## Reparaciones del propio cliente

Los productos de HP incluyen muchos componentes que el propio usuario puede reemplazar (*Customer Self Repair*, CSR) para minimizar el tiempo de reparación y ofrecer una mayor flexibilidad a la hora de realizar sustituciones de componentes defectuosos. Si, durante la fase de diagnóstico, HP (o los proveedores o socios de servicio de HP) identifica que una reparación puede llevarse a cabo mediante el uso de un componente CSR, HP le enviará dicho componente directamente para que realice su sustitución. Los componentes CSR se clasifican en dos categorías:

- **Obligatorio:** componentes para los que la reparación por parte del usuario es obligatoria. Si solicita a HP que realice la sustitución de estos componentes, tendrá que hacerse cargo de los gastos de desplazamiento y de mano de obra de dicho servicio.
- **Opcional:** componentes para los que la reparación por parte del usuario es opcional. Estos componentes también están diseñados para que puedan ser reparados por el usuario. Sin embargo, si precisa que HP realice su sustitución, puede o no conllevar costes adicionales, dependiendo del tipo de servicio de garantía correspondiente al producto.

**NOTA:** Algunos componentes no están diseñados para que puedan ser reparados por el usuario. Para que el usuario haga valer su garantía, HP pone como condición que un proveedor de servicios autorizado realice la sustitución de estos componentes. Dichos componentes se identifican con la palabra "No" en el catálogo ilustrado de componentes.

Según la disponibilidad y la situación geográfica, los componentes CSR se enviarán para que lleguen a su destino al siguiente día laborable. Si la situación geográfica lo permite, se puede solicitar la entrega en el mismo día o en cuatro horas con un coste adicional. Si precisa asistencia técnica, puede llamar al Centro de asistencia técnica de HP y recibirá ayuda telefónica por parte de un técnico. Con el envío de materiales para la sustitución de componentes CSR, HP especificará si los componentes defectuosos deberán devolverse a HP. En aquellos casos en los que sea necesario devolver algún componente a HP, deberá hacerlo en el periodo de tiempo especificado, normalmente cinco días laborables. Los componentes defectuosos deberán devolverse con toda la documentación relacionada y con el embalaje de envío. Si no

enviara el componente defectuoso requerido, HP podrá cobrarle por el de sustitución. En el caso de todas las sustituciones que lleve a cabo el cliente, HP se hará cargo de todos los gastos de envío y devolución de componentes y escogerá la empresa de transporte que se utilice para dicho servicio.

Para obtener más información acerca del programa de Reparaciones del propio cliente de HP, póngase en contacto con su proveedor de servicios local. Si está interesado en el programa para Norteamérica, visite la página web de HP siguiente (<http://www.hp.com/go/selfrepair>).

## Servicio de garantía exclusivo de componentes

La garantía limitada de HP puede que incluya un servicio de garantía exclusivo de componentes. Según las condiciones de este servicio exclusivo de componentes, HP le facilitará los componentes de repuesto sin cargo adicional alguno.

Para este servicio de garantía exclusivo de componentes, es obligatoria la sustitución de componentes por parte del usuario (CSR). Si solicita a HP que realice la sustitución de estos componentes, tendrá que hacerse cargo de los gastos de desplazamiento y de mano de obra de dicho servicio.

## Customer Self Repair

Veel onderdelen in HP producten zijn door de klant zelf te repareren, waardoor de reparatietaart tot een minimum beperkt kan blijven en de flexibiliteit in het vervangen van defecte onderdelen groter is. Deze onderdelen worden CSR-onderdelen (Customer Self Repair) genoemd. Als HP (of een HP Service Partner) bij de diagnose vaststelt dat de reparatie kan worden uitgevoerd met een CSR-onderdeel, verzendt HP dat onderdeel rechtstreeks naar u, zodat u het defecte onderdeel daarmee kunt vervangen. Er zijn twee categorieën CSR-onderdelen:

**Verplicht:** Onderdelen waarvoor reparatie door de klant verplicht is. Als u HP verzoekt deze onderdelen voor u te vervangen, worden u voor deze service reiskosten en arbeidsloon in rekening gebracht.

**Optioneel:** Onderdelen waarvoor reparatie door de klant optioneel is. Ook deze onderdelen zijn ontworpen voor reparatie door de klant. Als u echter HP verzoekt deze onderdelen voor u te vervangen, kunnen daarvoor extra kosten in rekening worden gebracht, afhankelijk van het type garantieservice voor het product.

**OPMERKING:** Sommige HP onderdelen zijn niet ontwikkeld voor reparatie door de klant. In verband met de garantievoorraarden moet het onderdeel door een geautoriseerde Service Partner worden vervangen. Deze onderdelen worden in de geillustreerde onderdelencatalogus aangemerkt met "Nee".

Afhankelijk van de leverbaarheid en de locatie worden CSR-onderdelen verzonden voor levering op de eerstvolgende werkdag. Levering op dezelfde dag of binnen vier uur kan tegen meerkosten worden aangeboden, indien dit mogelijk is gezien de locatie. Indien assistentie gewenst is, belt u een HP Service Partner om via de telefoon technische ondersteuning te ontvangen. HP vermeldt in de documentatie bij het vervangende CSR-onderdeel of het defecte onderdeel aan HP moet worden geretourneerd. Als het defecte onderdeel aan HP moet worden teruggezonden, moet u het defecte onderdeel binnen een bepaalde periode, gewoonlijk vijf (5) werkdagen, retourneren aan HP. Het defecte onderdeel moet met de bijbehorende documentatie worden geretourneerd in het meegeleverde verpakkingsmateriaal. Als u het defecte onderdeel niet terugzendt, kan HP u voor het vervangende onderdeel kosten in rekening brengen. Bij reparatie door de klant betaalt HP alle verzendkosten voor het vervangende en geretourneerde onderdeel en kiest HP zelf welke koerier/transportonderneming hiervoor wordt gebruikt.

Neem contact op met een Service Partner voor meer informatie over het Customer Self Repair programma van HP. Informatie over Service Partners vindt u op de HP website (<http://www.hp.com/go/selfrepair>).

## Garantieservice "Parts Only"

Het is mogelijk dat de HP garantie alleen de garantieservice "Parts Only" omvat. Volgens de bepalingen van de Parts Only garantieservice zal HP kosteloos vervangende onderdelen ter beschikking stellen.

Voor de Parts Only garantieservice is vervanging door CSR-onderdelen verplicht. Als u HP verzoekt deze onderdelen voor u te vervangen, worden u voor deze service reiskosten en arbeidsloon in rekening gebracht.

## Reparo feito pelo cliente

Os produtos da HP são projetados com muitas peças para reparo feito pelo cliente (CSR) de modo a minimizar o tempo de reparo e permitir maior flexibilidade na substituição de peças com defeito. Se, durante o período de diagnóstico, a HP (ou fornecedores/partneiros de serviço da HP) concluir que o reparo pode ser efetuado pelo uso de uma peça CSR, a peça de reposição será enviada diretamente ao cliente. Existem duas categorias de peças CSR:

Obrigatória – Peças cujo reparo feito pelo cliente é obrigatório. Se desejar que a HP substitua essas peças, serão cobradas as despesas de transporte e mão-de-obra do serviço.

Opcional – Peças cujo reparo feito pelo cliente é opcional. Essas peças também são projetadas para o reparo feito pelo cliente. No entanto, se desejar que a HP as substitua, pode haver ou não a cobrança de taxa adicional, dependendo do tipo de serviço de garantia destinado ao produto.

**OBSERVAÇÃO:** Algumas peças da HP não são projetadas para o reparo feito pelo cliente. A fim de cumprir a garantia do cliente, a HP exige que um técnico autorizado substitua a peça. Essas peças estão identificadas com a marca "No" (Não), no catálogo de peças ilustrado.

Conforme a disponibilidade e o local geográfico, as peças CSR serão enviadas no primeiro dia útil após o pedido. Onde as condições geográficas permitirem, a entrega no mesmo dia ou em quatro horas pode ser feita mediante uma taxa adicional. Se precisar de auxílio, entre em contato com o Centro de suporte técnico da HP para que um técnico o ajude por telefone. A HP especifica nos materiais fornecidos com a peça CSR de reposição se a peça com defeito deve ser devolvida à HP. Nos casos em que isso for necessário, é preciso enviar a peça com defeito à HP dentro do período determinado, normalmente cinco (5) dias úteis. A peça com defeito deve ser enviada com a documentação correspondente no material de transporte fornecido. Caso não o faça, a HP poderá cobrar a reposição. Para as peças de reparo feito pelo cliente, a HP paga todas as despesas de transporte e de devolução da peça e determina a transportadora/serviço postal a ser utilizado.

Para obter mais informações sobre o programa de reparo feito pelo cliente da HP, entre em contato com o fornecedor de serviços local. Para o programa norte-americano, visite o site da HP (<http://www.hp.com/go/selfrepair>).

## Serviço de garantia apenas para peças

A garantia limitada da HP pode incluir um serviço de garantia apenas para peças. Segundo os termos do serviço de garantia apenas para peças, a HP fornece as peças de reposição sem cobrar nenhuma taxa.

No caso desse serviço, a substituição de peças CSR é obrigatória. Se desejar que a HP substitua essas peças, serão cobradas as despesas de transporte e mão-de-obra do serviço.

## カスタマーセルフリペア

修理時間を短縮し、故障部品の交換における高い柔軟性を確保するために、HP製品には多数のCSR部品があります。診断の際に、CSR部品を使用すれば修理ができるとHP（HPまたはHP正規保守代理店）が判断した場合、HPはその部品を直接、お客様に発送し、お客様に交換していただきます。CSR部品には以下の2通りがあります。

- 必須 - カスタマーセルフリペアが必須の部品。当該部品について、もしもお客様がHPに交換作業を依頼される場合には、その修理サービスに関する交通費および人件費がお客様に請求されます。
- 任意 - カスタマーセルフリペアが任意である部品。この部品もカスタマーセルフリペア用です。当該部品について、もしもお客様がHPに交換作業を依頼される場合には、お買い上げの製品に適用される保証サービス内容の範囲内においては、別途費用を負担していただくことなく保証サービスを受けることができます。

注： HP製品の一部の部品は、カスタマーセルフリペア用ではありません。製品の保証を継続するためには、HPまたはHP正規保守代理店による交換作業が必須となります。部品カタログには、当該部品がカスタマーセルフリペア除外品である旨が記載されています。

部品供給が可能な場合、地域によっては、CSR部品を翌営業日に届くように発送します。また、地域によっては、追加費用を負担いただくことにより同日または4時間以内に届くように発送することも可能な場合があります。サポートが必要なときは、HPの修理受付窓口に電話していただければ、技術者が電話でアドバイスします。交換用のCSR部品または同梱物には、故障部品をHPに返送する必要があるかどうかが表示されています。故障部品をHPに返送する必要がある場合は、指定期限内（通常は5営業日以内）に故障部品をHPに返送してください。故障部品を返送する場合は、届いた時の梱包箱に関連書類とともに入れてください。故障部品を返送しない場合、HPから部品費用が請求されます。カスタマーセルフリペアの際には、HPは送料および部品返送費を全額負担し、使用する宅配便会社や運送会社を指定します。

## 部品のみ保証サービス

HP保証サービスには、部品のみ保証サービスが適用される場合があります。このサービスでは、交換部品は無償で提供されます。

部品のみ保証サービスにおいては、CSR部品をお客様により交換作業していただくことが必須となります。当該部品について、もしもお客様がHPに交換作業を依頼される場合には、その修理サービスに関する交通費および人件費はお客様の負担となります。

## 客户自行维修

HP 产品提供许多客户自行维修 (CSR) 部件，以尽可能缩短维修时间和在更换缺陷部件方面提供更大的灵活性。如果在诊断期间 HP（或 HP 服务提供商或服务合作伙伴）确定可以通过使用 CSR 部件完成维修，HP 将直接把该部件发送给您进行更换。有两类 CSR 部件：

- **强制性的** — 要求客户必须自行维修的部件。如果您请求 HP 更换这些部件，则必须为该服务支付差旅费和人工费用。
- **可选的** — 客户可以选择是否自行维修的部件。这些部件也是为客户自行维修设计的。不过，如果您要求 HP 为您更换这些部件，则根据为您的产品指定的保修服务类型，HP 可能收取或不再收取任何附加费用。

**注：**某些 HP 部件的设计并未考虑客户自行维修。为了满足客户保修的需要，HP 要求授权服务提供商更换相关部件。这些部件在部件图解目录中标记为“否”。

CSR 部件将在下一个工作日发运（取决于备货情况和允许的地理范围）。在允许的地理范围内，可在当天或四小时内发运，但要收取额外费用。如果需要帮助，您可以致电 HP 技术支持中心，将会有技术人员通过电话为您提供帮助。HP 会在随更换的 CSR 部件发运的材料中指明是否必须将有缺陷的部件返还给 HP。如果要求您将有缺陷的部件返还给 HP，那么您必须在规定期限内（通常是五 (5) 个工作日）将缺陷部件发给 HP。有缺陷的部件必须随所提供的发运材料中的相关文件一起返还。如果未能送还有缺陷的部件，HP 可能会要求您支付更换费用。客户自行维修时，HP 将承担所有相关运输和部件返回费用，并指定快递商/承运商。

有关 HP 客户自行维修计划的详细信息，请与您当地的服务提供商联系。有关北美地区的计划，请访问 HP 网站 (<http://www.hp.com/go/selfrepair>)。

## 仅部件保修服务

您的 HP 有限保修服务可能涉及仅部件保修服务。根据仅部件保修服务条款的规定，HP 将免费提供更换的部件。

仅部件保修服务要求进行 CSR 部件更换。如果您请求 HP 更换这些部件，则必须为该服务支付差旅费和人工费用。

## 客戶自行維修

HP 產品設計了許多「客戶自行維修」(CSR) 的零件以減少維修時間，並且使得更換瑕疵零件時能有更大的彈性。如果在診斷期間 HP (或 HP 服務供應商或維修夥伴) 辨認出此項維修工作可以藉由使用 CSR 零件來完成，則 HP 將直接寄送該零件給您作更換。CSR 零件分為兩種類別：

- **強制的** — 客戶自行維修所使用的零件是強制性的。如果您要求 HP 更換這些零件，HP 將會向您收取此服務所需的外出費用與勞動成本。
- **選購的** — 客戶自行維修所使用的零件是選購的。這些零件也設計用於客戶自行維修之用。不過，如果您要求 HP 為您更換，則可能需要也可能不需要負擔額外的費用，端視針對此產品指定的保固服務類型而定。

**備註：**某些 HP 零件沒有消費者可自行維修的設計。為符合客戶保固，HP 需要授權的服務供應商更換零件。這些零件在圖示的零件目錄中，被標示為「否」。

基於材料取得及環境允許的情況下，CSR 零件將於下一個工作日以快遞寄送。在環境的允許下當天或四小時內送達，則可能需要額外的費用。若您需要協助，可致電「HP 技術支援中心」，會有一位技術人員透過電話來協助您。不論損壞的零件是否必須退回，HP 皆會在與 CSR 替換零件一起運送的材料中註明。若要將損壞的零件退回 HP，您必須在指定的一段時間內（通常為五 (5) 個工作天），將損壞的零件寄回 HP。損壞的零件必須與寄送資料中隨附的相關技術文件一併退還。如果無法退還損壞的零件，HP 可能要向您收取替換費用。針對客戶自行維修情形，HP 將負責所有運費及零件退還費用並指定使用何家快遞/貨運公司。

如需 HP 的「客戶自行維修」方案詳細資訊，請連絡您當地的服務供應商。至於北美方案，請參閱 HP 網站 (<http://www.hp.com/go/selfrepair>)。

## 僅限零件的保固服務

您的「HP 有限保固」可能包含僅限零件的保固服務。在僅限零件的保固服務情況下，HP 將免費提供替換零件。

針對僅限零件的保固服務，CSR 零件替換是強制性的。如果您要求 HP 更換這些零件，HP 將會向您收取此服務所需的外出費用與勞動成本。

## 고객 셀프 수리

HP 제품은 수리 시간을 최소화하고 결함이 있는 부품 교체 시 더욱 융통성을 발휘할 수 있도록 하기 위해 고객 셀프 수리(CSR) 부품을 다량 사용하여 설계되었습니다. 진단 기간 동안 HP(또는 HP 서비스 공급업체 또는 서비스 협력업체)에서 CSR 부품을 사용하여 수리가 가능하다고 판단되면 HP는 해당 부품을 바로 사용자에게 보내어 사용자가 교체 할 수 있도록 합니다. CSR 부품에는 두 가지 종류가 있습니다.

- **고객 셀프 수리가 의무 사항인 필수 부품.** 사용자가 HP에 이 부품의 교체를 요청할 경우 이 서비스에 대한 출장비 및 작업비가 청구됩니다.
- **고객 셀프 수리가 선택 사항인 부품.** 이 부품들도 고객 셀프 수리가 가능하도록 설계되었습니다. 하지만 사용자가 HP에 이 부품의 교체를 요청할 경우 사용자가 구입한 제품에 해당하는 보증 서비스 유형에 따라 추가 비용 없이 교체가 가능할 수 있습니다.

**참고:** 일부 HP 부품은 고객 셀프 수리가 불가능하도록 설계되었습니다. HP는 만족스러운 고객 보증을 위해 공인 서비스 제공업체를 통해 부품을 교체하도록 하고 있습니다. 이러한 부품들은 Illustrated Parts Catalog에 "No"라고 표시되어 있습니다.

CSR 부품은 재고 상태와 지리적 조건이 허용하는 경우 다음 영업일 납품이 가능하도록 배송이 이루어집니다. 지리적 조건이 허용하는 경우 추가 비용이 청구되는 조건으로 당일 또는 4시간 배송이 가능할 수도 있습니다. 도움이 필요하시면 HP 기술 지원 센터로 전화하십시오. 전문 기술자가 전화로 도움을 줄 것입니다. HP는 결함이 발생한 부품을 HP로 반환해야 하는지 여부를 CSR 교체 부품과 함께 배송된 자료에 지정합니다. 결함이 발생한 부품을 HP로 반환해야 하는 경우에는 지정된 기간 내(통상 영업일 기준 5일)에 HP로 반환해야 합니다. 이 때 결함이 발생한 부품은 제공된 포장 재료에 넣어 관련 설명서와 함께 반환해야 합니다. 결함이 발생한 부품을 반환하지 않는 경우 HP가 교체 부품에 대해 비용을 청구할 수 있습니다. 고객 셀프 수리의 경우, HP는 모든 운송 및 부품 반환 비용을 부담하며 이용할 운송업체 및 택배 서비스를 결정합니다.

HP 고객 셀프 수리 프로그램에 대한 자세한 내용은 가까운 서비스 제공업체에 문의하십시오. 북미 지역의 프로그램에 대해서는 HP 웹 사이트(<http://www.hp.com/go/selfrepair>)를 참조하십시오.

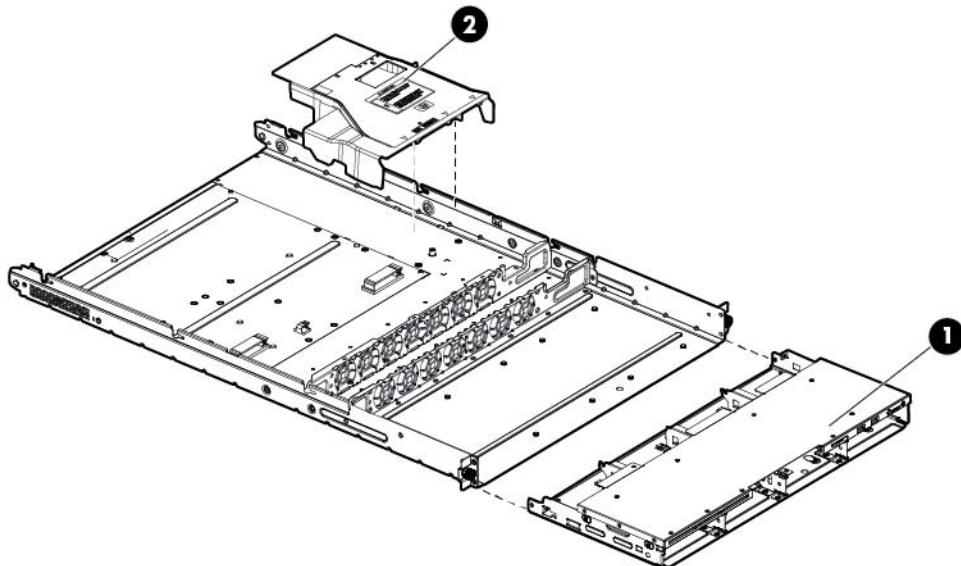
## 부품 제공 보증 서비스

HP 제한 보증에는 부품 제공 보증 서비스가 포함될 수 있습니다. 이러한 경우 HP는 부품 제공 보증 서비스의 조건에 따라 교체 부품만을 무료로 제공합니다.

부품 제공 보증 서비스 제공 시 CSR 부품 교체는 의무 사항입니다. 사용자가 HP에 이 부품의 교체를 요청할 경우 이 서비스에 대한 출장비 및 작업비가 청구됩니다.

# Illustrated parts catalog

## Mechanical components



Item	Description	Spare part number	Customer self repair (on page 5)
1	LFF drive cage	532114-001	Mandatory <sup>1</sup>
2	Air baffle	644673-001	Mandatory <sup>1</sup>
3	SFF drive cage*	532480-001	Mandatory <sup>1</sup>
4	Heatsink*	646404-001	Mandatory <sup>1</sup>
5	Hardware kit*	573091-001	Mandatory <sup>1</sup>
	a) Friction rail, left*	—	Mandatory <sup>1</sup>
	b) Friction rail, right*	—	Mandatory <sup>1</sup>

\* Not shown

<sup>1</sup>Mandatory—Parts for which customer self repair is mandatory. If you request HP to replace these parts, you will be charged for the travel and labor costs of this service.

<sup>2</sup>Optional—Parts for which customer self repair is optional. These parts are also designed for customer self repair. If, however, you require that HP replace them for you, there may or may not be additional charges, depending on the type of warranty service designated for your product.

<sup>3</sup>No—Some HP parts are not designed for customer self repair. In order to satisfy the customer warranty, HP requires that an authorized service provider replace the part. These parts are identified as "No" in the Illustrated Parts Catalog.

<sup>1</sup>Mandatory: Obligatoire—Pièces pour lesquelles la réparation par le client est obligatoire. Si vous demandez à HP de remplacer ces pièces, les coûts de déplacement et main d'œuvre du service vous seront facturés.

<sup>2</sup>Optional: Facultatif—Pièces pour lesquelles la réparation par le client est facultative. Ces pièces sont également conçues pour permettre au client d'effectuer lui-même la réparation. Toutefois, si vous demandez à HP de remplacer ces pièces, l'intervention peut ou non vous être facturée, selon le type de garantie applicable à votre produit.

<sup>3</sup>No: Non—Certaines pièces HP ne sont pas conçues pour permettre au client d'effectuer lui-même la réparation. Pour que la garantie puisse s'appliquer, HP exige que le remplacement de la pièce soit effectué par un Mainteneur Agréé. Ces pièces sont identifiées par la mention "Non" dans le Catalogue illustré.

<sup>1</sup>Mandatory: Obbligatorie—Parti che devono essere necessariamente riparate dal cliente. Se il cliente ne affida la riparazione ad HP, deve sostenere le spese di spedizione e di manodopera per il servizio.

<sup>2</sup>Optional: Opzionali—Parti la cui riparazione da parte del cliente è facoltativa. Si tratta comunque di componenti progettati per questo scopo. Se tuttavia il cliente ne richiede la sostituzione ad HP, potrebbe dover sostenere spese addizionali a seconda del tipo di garanzia previsto per il prodotto.

<sup>3</sup>No: Non CSR—Alcuni componenti HP non sono progettati per la riparazione da parte del cliente. Per rispettare la garanzia, HP richiede che queste parti siano sostituite da un centro di assistenza autorizzato. Tali parti sono identificate da un "No" nel Catalogo illustrato dei componenti.

<sup>1</sup>Mandatory: Zwingend—Teile, die im Rahmen des Customer Self Repair Programms ersetzt werden müssen. Wenn Sie diese Teile von HP ersetzen lassen, werden Ihnen die Versand- und Arbeitskosten für diesen Service berechnet.

<sup>2</sup>Optional: Optional—Teile, für die das Customer Self Repair-Verfahren optional ist. Diese Teile sind auch für Customer Self Repair ausgelegt. Wenn Sie jedoch den Austausch dieser Teile von HP vornehmen lassen möchten, können bei diesem Service je nach den für Ihr Produkt vorgesehenen Garantiebedingungen zusätzliche Kosten anfallen.

<sup>3</sup>No: Kein—Einige Teile sind nicht für Customer Self Repair ausgelegt. Um den Garantieanspruch des Kunden zu erfüllen, muss das Teil von einem HP Servicepartner ersetzt werden. Im illustrierten Teilekatalog sind diese Teile mit „No“ bzw. „Nein“ gekennzeichnet.

<sup>1</sup>Mandatory: Obligatorio—componentes para los que la reparación por parte del usuario es obligatoria. Si solicita a HP que realice la sustitución de estos componentes, tendrá que hacerse cargo de los gastos de desplazamiento y de mano de obra de dicho servicio.

<sup>2</sup>Optional: Opcional— componentes para los que la reparación por parte del usuario es opcional. Estos componentes también están diseñados para que puedan ser reparados por el usuario. Sin embargo, si precisa que HP realice su sustitución, puede o no conllevar costes adicionales, dependiendo del tipo de servicio de garantía correspondiente al producto.

<sup>3</sup>No: No—Algunos componentes no están diseñados para que puedan ser reparados por el usuario. Para que el usuario haga valer su garantía, HP pone como condición que un proveedor de servicios autorizado realice la sustitución de estos componentes. Dichos componentes se identifican con la palabra "No" en el catálogo ilustrado de componentes.

<sup>1</sup>Mandatory: Verplicht—Onderdelen waarvoor Customer Self Repair verplicht is. Als u HP verzoekt deze onderdelen te vervangen, komen de reiskosten en het arbeidsloon voor uw rekening.

<sup>2</sup>Optional: Optioneel—Onderdelen waarvoor reparatie door de klant optioneel is. Ook deze onderdelen zijn ontworpen voor reparatie door de klant. Als u echter HP verzoekt deze onderdelen voor u te vervangen, kunnen daarvoor extra kosten in rekening worden gebracht, afhankelijk van het type garantieservice voor het product.

<sup>3</sup>No: Nee—Sommige HP onderdelen zijn niet ontwikkeld voor reparatie door de klant. In verband met de garantievoorraarden moet het onderdeel door een geautoriseerde Service Partner worden vervangen. Deze onderdelen worden in de geïllustreerde onderdelencatalogus aangemerkt met "Nee".

<sup>1</sup>Mandatory: Obrigatória—Peças cujo reparo feito pelo cliente é obrigatório. Se desejar que a HP substitua essas peças, serão cobradas as despesas de transporte e mão-de-obra do serviço.

<sup>2</sup>Optional: Opcional—Peças cujo reparo feito pelo cliente é opcional. Essas peças também são projetadas para o reparo feito pelo cliente. No entanto, se desejar que a HP as substitua, pode haver ou não a cobrança de taxa adicional, dependendo do tipo de serviço de garantia destinado ao produto.

<sup>3</sup>No: Nenhuma—Algumas peças da HP não são projetadas para o reparo feito pelo cliente. A fim de cumprir a garantia do cliente, a HP exige que um técnico autorizado substitua a peça. Essas peças estão identificadas com a marca "No" (Não), no catálogo de peças ilustrado.

<sup>1</sup>Mandatory : 必須 - 顧客自己修理が必須の部品。当該部品について、もしもお客様がHPに交換作業を依頼される場合には、その修理サービスに関する交通費および人件費がお客様に請求されます。

<sup>2</sup>Optional : 任意 - 顧客自己修理が任意である部品。この部品も顧客自己修理用です。当該部品について、もしもお客様がHPに交換作業を依頼される場合には、お買い上げの製品に適用される保証サービス内容の範囲内においては、費用を負担していただくことなく保証サービスを受けることができます。

<sup>3</sup>No : 除外 - HP製品の一部の部品は、顧客自己修理用ではありません。製品の保証を継続するためには、HPまたはHP正規保守代理店による交換作業が必須となります。部品カタログには、当該部品が顧客自己修理除外品である旨が記載されています。

<sup>1</sup>Mandatory: 强制性的 — 要求客户必须自行维修的部件。如果您请求 HP 更换这些部件，则必须为该服务支付差旅费和人工费用。

<sup>2</sup>Optional: 可选的 — 客户可以选择是否自行维修的部件。这些部件也是为客户自行维修设计的。不过，如果您要求 HP 为您更换这些部件，则根据为您的产品指定的保修服务类型，HP 可能收取或不再收取任何附加费用。

<sup>3</sup>No: 否 — 某些 HP 部件的设计并未考虑客户自行维修。为了满足客户保修的需要，HP 要求授权服务提供商更换相关部件。这些部件在部件图解目录中标记为“否”。

<sup>1</sup>Mandatory: 強制的 — 客戶自行維修所使用的零件是強制性的。如果您要求 HP 更換這些零件，HP 將會向您收取此服務所需的外出費用與勞動成本。

<sup>2</sup>Optional: 選購的 — 客戶自行維修所使用的零件是選購的。這些零件也設計用於客戶自行維修之用。不過，如果您要求 HP 為您更換，則可能需要也可能不需要負擔額外的費用，端視針對此產品指定的保固服務類型而定。

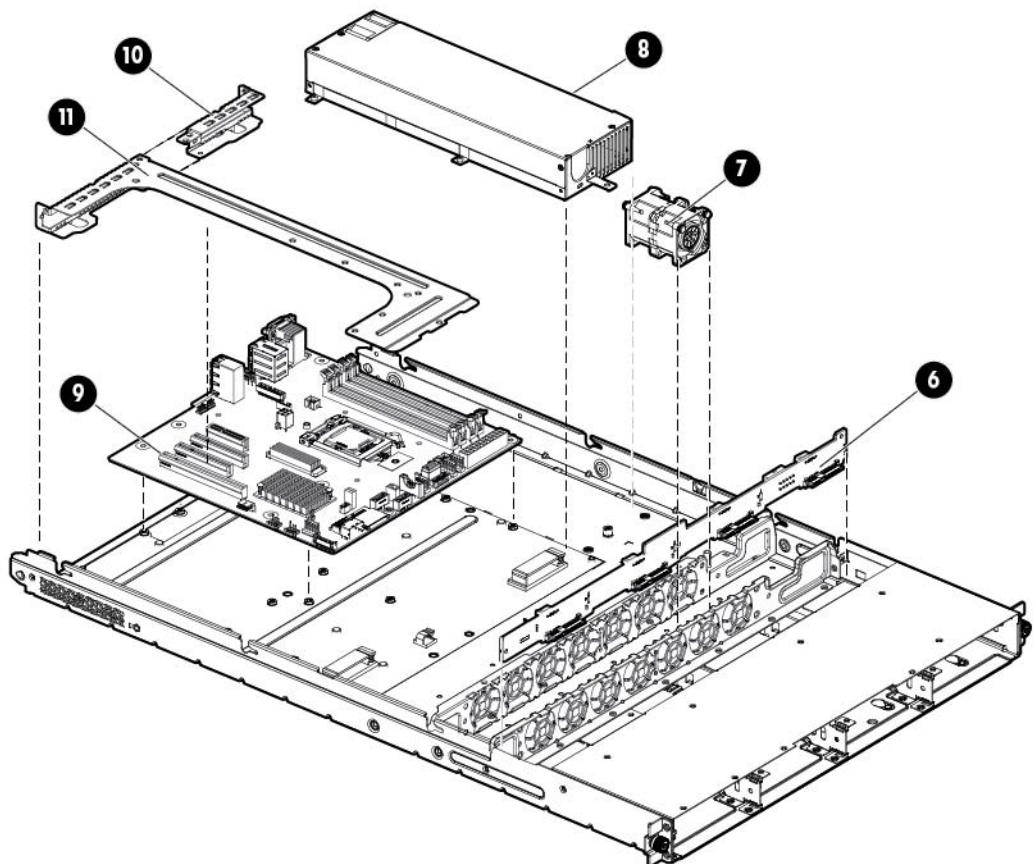
<sup>3</sup>No: 否 — 某些 HP 零件沒有消費者可自行維修的設計。為符合客戶保固，HP 需要授權的服務供應商更換零件。這些零件在圖示的零件目錄中，被標示為「否」。

<sup>1</sup> Mandatory: 필수 — 고객 셀프 수리가 의무 사항인 필수 부품. 사용자가 HP에 이 부품의 교체를 요청할 경우 이 서비스에 대한 출장비 및 작업비가 청구됩니다.

<sup>2</sup> Optional: 옵션 — 고객 셀프 수리가 선택 사항인 부품. 이 부품들도 고객 셀프 수리가 가능하도록 설계되었습니다. 하지만 사용자가 HP에 이 부품의 교체를 요청할 경우 사용자가 구입한 제품에 해당하는 보증 서비스 유형에 따라 추가 비용 없이 교체가 가능할 수 있습니다.

<sup>3</sup> No: No — 고객 셀프 수리가 불가능하도록 설계된 HP 부품. 이 부품들은 고객 셀프 수리가 불가능하도록 설계되었습니다. HP는 고객 보증을 만족시키기 위해 공인 서비스 제공업체를 통해 부품을 교체하도록 하고 있습니다.

# System components



Item	Description	Spare part number	Customer self repair (on page 5)
6	LFF drive cage backplane	570079-001	Mandatory <sup>1</sup>
7	Fan module	519711-001	Mandatory <sup>1</sup>
8	<b>Power supply</b>	—	—
	a) HP ProLiant 400-W nonredundant power supply assembly	664775-001	Mandatory <sup>1</sup>
	b) HP ProLiant 400-W redundant hot-plug power supply module*	532478-001	Mandatory <sup>1</sup>
	c) HP ProLiant 400-W redundant hot-plug power supply backplane with cage*	532479-001	Mandatory <sup>1</sup>
	<b>Boards</b>	—	—
9	System board assembly	644671-001	Mandatory <sup>1</sup>
10	Low profile PCIe riser board	511809-001	Mandatory <sup>1</sup>
11	Full-length PCIe riser board	511808-001	Mandatory <sup>1</sup>
12	HP Trusted Platform Module*	505836-001	Mandatory <sup>1</sup>
13	HP Smart Array P212 controller card*	462594-001	Mandatory <sup>1</sup>
14	HP Dedicated Management Port (option)*	575058-001	Mandatory <sup>1</sup>
	<b>Media drives</b>	—	—

<b>Item</b>	<b>Description</b>	<b>Spare part number</b>	<b>Customer self repair (on page 5)</b>
15	SATA DVD-ROM 9.5mm optical disk drive*	481430-001	Mandatory <sup>1</sup>
16	SATA DVD-RW 9.5mm optical disk drive*	481431-001	Mandatory <sup>1</sup>
	<b>Storage drives</b>	—	—
17	Non-hot-plug drives	—	—
	a) 160-GB, SATA, 7,200-rpm, LFF drive*	483096-001	Mandatory <sup>1</sup>
	b) 250-GB, SATA, 7,200-rpm, LFF drive*	571517-001	Mandatory <sup>1</sup>
	c) 450-GB, SAS, 15,000-rpm, LFF drive*	517353-001	Mandatory <sup>1</sup>
	d) 500-GB, SATA, 7,200-rpm, LFF drive*	459316-001	Mandatory <sup>1</sup>
	e) 600-GB, SAS, 15,000-rpm, LFF drive*	517355-001	Mandatory <sup>1</sup>
	f) 1-TB, SATA, 7,200-rpm, LFF drive*	508039-001	Mandatory <sup>1</sup>
	g) 2-TB, SATA, 7,200-rpm, LFF drive*	508041-001	Mandatory <sup>1</sup>
18	Hot-plug drives	—	—
	a) 160-GB, SATA, 7,200-rpm, LFF drive*	574269-001	Mandatory <sup>1</sup>
	b) 250-GB, SATA, 7,200-rpm, LFF drive*	571516-001	Mandatory <sup>1</sup>
	c) 300-GB, SAS, 15,000-rpm, LFF drive*	517350-001	Mandatory <sup>1</sup>
	d) 450-GB, SAS, 15,000-rpm, LFF drive*	517352-001	Mandatory <sup>1</sup>
	e) 500-GB, SATA, 7,200-rpm, LFF drive*	459319-001	Mandatory <sup>1</sup>
	f) 600-GB, SAS, 15,000-rpm, LFF drive*	517354-001	Mandatory <sup>1</sup>
	g) 750-GB, SATA, 7,200-rpm, LFF drive*	459320-001	Mandatory <sup>1</sup>
	h) 900-GB, SAS, 10,000-rpm, SFF drive*	619463-001	Mandatory <sup>1</sup>
	i) 1-TB, SATA, 7,200-rpm, LFF drive*	454273-001	Mandatory <sup>1</sup>
	j) 1-TB, SAS, 7,200-rpm, LFF drive*	653947-001	Mandatory <sup>1</sup>
	k) 1-TB, SAS, 7,200-rpm, SFF drive*	606020-001	Mandatory <sup>1</sup>
	l) 2-TB, SATA, 7,200-rpm, LFF drive*	508040-001	Mandatory <sup>1</sup>
	m) 2-TB, SAS, 7,200-rpm, LFF drive*	508010-001	Mandatory <sup>1</sup>
	<b>Memory</b>	—	—
19	a) 1-GB PC3-10600E UDIMM ECC (RoHS)*	501539-001	Mandatory <sup>1</sup>
	b) 2-GB PC3-10600E UDIMM ECC (RoHS)*	501540-001	Mandatory <sup>1</sup>
	c) 4-GB PC3-10600E UDIMM ECC (RoHS)*	501541-001	Mandatory <sup>1</sup>
	d) 8-GB PC3-10600E UDIMM ECC (RoHS)*	664696-001	Mandatory <sup>1</sup>
20	<b>Processors</b>	—	—
	a) 2.2-GHz Intel Xeon E3-1220L processor, 2C, 3-MB, 20-W*	648253-001	Mandatory <sup>1</sup>
	b) 2.4-GHz Intel Celeron G530 processor, 2C, 2-MB, 65-W*	664771-001	Mandatory <sup>1</sup>
	c) 2.6-GHz Intel Pentium G620 processor, 2C, 3-MB, 65-W*	656461-001	Mandatory <sup>1</sup>
	d) 2.7-GHz Intel Pentium G630 processor, 2C, 3-MB,	664772-001	Mandatory <sup>1</sup>

<b>Item</b>	<b>Description</b>	<b>Spare part number</b>	<b>Customer self repair (on page 5)</b>
	65-W*		
	e) 2.8-GHz Intel Pentium G840 processor, 2C, 3-MB, 65-W*	656462-001	Mandatory <sup>1</sup>
	f) 2.9-GHz Intel Pentium G850 processor, 2C, 3-MB, 65-W*	656463-001	Mandatory <sup>1</sup>
	g) 3-GHz Intel Pentium G860 processor, 2C, 3-MB, 65-W*	664773-001	Mandatory <sup>1</sup>
	h) 3.1-GHz Intel Xeon i3-2100 processor, 2C 3-MB, 65-W*	644761-001	Mandatory <sup>1</sup>
	i) 3.3-GHz Intel Xeon i3-2120 processor, 2C, 3-MB, 65-W*	644762-001	Mandatory <sup>1</sup>
	j) 3.4-GHz Intel Xeon i3-2130 processor, 2C, 3-MB, 65-W*	664774-001	Mandatory <sup>1</sup>
	k) 3.1-GHz Intel Xeon E3-1220 processor, 4C, 8-MB, 80-W*	644753-001	Mandatory <sup>1</sup>
	l) 3.2-GHz Intel Xeon E3-1230 processor, 4C, 8-MB, 80-W*	644754-001	Mandatory <sup>1</sup>
	m) 3.3-GHz Intel Xeon E3-1240 processor, 4C, 8-MB, 80-W*	644755-001	Mandatory <sup>1</sup>
	n) 3.4-GHz Intel Xeon E3-1270 processor, 4C, 8-MB, 80-W*	644756-001	Mandatory <sup>1</sup>
	o) 3.5-GHz Intel Xeon E3-1280 processor, 4C, 8-MB, 95-W*	648254-001	Mandatory <sup>1</sup>
	<b>Cables</b>	—	—
21	SATA power/data cable*	531997-001	Mandatory <sup>1</sup>
22	I <sup>2</sup> C cable assembly*	511818-001	Mandatory <sup>1</sup>
23	SATA to mini-SAS cable assembly*	580751-001	Mandatory <sup>1</sup>
24	Front USB cable assembly*	603892-001	Mandatory <sup>1</sup>
25	SATA 670mm power/data cable*	532474-001	Mandatory <sup>1</sup>

\*Not shown

<sup>1</sup>Mandatory—Parts for which customer self repair is mandatory. If you request HP to replace these parts, you will be charged for the travel and labor costs of this service.

<sup>2</sup>Optional—Parts for which customer self repair is optional. These parts are also designed for customer self repair. If, however, you require that HP replace them for you, there may or may not be additional charges, depending on the type of warranty service designated for your product.

<sup>3</sup>No—Some HP parts are not designed for customer self repair. In order to satisfy the customer warranty, HP requires that an authorized service provider replace the part. These parts are identified as "No" in the Illustrated Parts Catalog.

<sup>1</sup>Mandatory: Obligatoire—Pièces pour lesquelles la réparation par le client est obligatoire. Si vous demandez à HP de remplacer ces pièces, les coûts de déplacement et main d'œuvre du service vous seront facturés.

<sup>2</sup>Optional: Facultatif—Pièces pour lesquelles la réparation par le client est facultative. Ces pièces sont également conçues pour permettre au client d'effectuer lui-même la réparation. Toutefois, si vous demandez à HP de remplacer ces pièces, l'intervention peut ou non vous être facturée, selon le type de garantie applicable à votre produit.

<sup>3</sup>No: Non—Certaines pièces HP ne sont pas conçues pour permettre au client d'effectuer lui-même la réparation. Pour que la garantie puisse s'appliquer, HP exige que le remplacement de la pièce soit effectué par un Mainteneur Agréé. Ces pièces sont identifiées par la mention "Non" dans le Catalogue illustré.

<sup>1</sup>Mandatory: Obbligatorie—Parti che devono essere necessariamente riparate dal cliente. Se il cliente ne affida la riparazione ad HP, deve sostenere le spese di spedizione e di manodopera per il servizio.

<sup>2</sup>Optional: Opzional—Parti la cui riparazione da parte del cliente è facoltativa. Si tratta comunque di componenti progettati per questo scopo. Se tuttavia il cliente ne richiede la sostituzione ad HP, potrebbe dover sostenere spese addizionali a seconda del tipo di garanzia previsto per il prodotto.

<sup>3</sup>No: Non CSR—Alcuni componenti HP non sono progettati per la riparazione da parte del cliente. Per rispettare la garanzia, HP richiede che queste parti siano sostituite da un centro di assistenza autorizzato. Tali parti sono identificate da un "No" nel Catalogo illustrato dei componenti.

<sup>1</sup>Mandatory: Zwingend—Teile, die im Rahmen des Customer Self Repair Programms ersetzt werden müssen. Wenn Sie diese Teile von HP ersetzen lassen, werden Ihnen die Versand- und Arbeitskosten für diesen Service berechnet.

<sup>2</sup>Optional: Optional—Teile, für die das Customer Self Repair-Verfahren optional ist. Diese Teile sind auch für Customer Self Repair ausgelegt. Wenn Sie jedoch den Austausch dieser Teile von HP vornehmen lassen möchten, können bei diesem Service je nach den für Ihr Produkt vorgesehenen Garantiebedingungen zusätzliche Kosten anfallen.

<sup>3</sup>No: Kein—Einige Teile sind nicht für Customer Self Repair ausgelegt. Um den Garantieanspruch des Kunden zu erfüllen, muss das Teil von einem HP Servicepartner ersetzt werden. Im illustrierten Teilekatalog sind diese Teile mit „No“ bzw. „Nein“ gekennzeichnet.

<sup>1</sup>Mandatory: Obligatorio—componentes para los que la reparación por parte del usuario es obligatoria. Si solicita a HP que realice la sustitución de estos componentes, tendrá que hacerse cargo de los gastos de desplazamiento y de mano de obra de dicho servicio.

<sup>2</sup>Optional: Opcional— componentes para los que la reparación por parte del usuario es opcional. Estos componentes también están diseñados para que puedan ser reparados por el usuario. Sin embargo, si precisa que HP realice su sustitución, puede o no conllevar costes adicionales, dependiendo del tipo de servicio de garantía correspondiente al producto.

<sup>3</sup>No: No—Algunos componentes no están diseñados para que puedan ser reparados por el usuario. Para que el usuario haga valer su garantía, HP pone como condición que un proveedor de servicios autorizado realice la sustitución de estos componentes. Dichos componentes se identifican con la palabra "No" en el catálogo ilustrado de componentes.

<sup>1</sup>Mandatory: Verplicht—Onderdelen waarvoor Customer Self Repair verplicht is. Als u HP verzoekt deze onderdelen te vervangen, komen de reiskosten en het arbeidsloon voor uw rekening.

<sup>2</sup>Optional: Optioneel—Onderdelen waarvoor reparatie door de klant optioneel is. Ook deze onderdelen zijn ontworpen voor reparatie door de klant. Als u echter HP verzoekt deze onderdelen voor u te vervangen, kunnen daarvoor extra kosten in rekening worden gebracht, afhankelijk van het type garantieservice voor het product.

<sup>3</sup>No: Nee—Sommige HP onderdelen zijn niet ontwikkeld voor reparatie door de klant. In verband met de garantievoorraarden moet het onderdeel door een geautoriseerde Service Partner worden vervangen. Deze onderdelen worden in de geillustreerde onderdelencatalogus aangemerkt met "Nee".

<sup>1</sup>Mandatory: Obrigatória—Peças cujo reparo feito pelo cliente é obrigatório. Se desejar que a HP substitua essas peças, serão cobradas as despesas de transporte e mão-de-obra do serviço.

<sup>2</sup>Optional: Opcional—Peças cujo reparo feito pelo cliente é opcional. Essas peças também são projetadas para o reparo feito pelo cliente. No entanto, se desejar que a HP as substitua, pode haver ou não a cobrança de taxa adicional, dependendo do tipo de serviço de garantia destinado ao produto.

<sup>3</sup>No: Nenhuma—Algumas peças da HP não são projetadas para o reparo feito pelo cliente. A fim de cumprir a garantia do cliente, a HP exige que um técnico autorizado substitua a peça. Essas peças estão identificadas com a marca "No" (Não), no catálogo de peças ilustrado.

<sup>1</sup>Mandatory : 必須 - 顧客自己修理が必須の部品。当該部品について、もしもお客様がHPに交換作業を依頼される場合には、その修理サービスに関する交通費および人件費がお客様に請求されます。

<sup>2</sup>Optional : 任意 - 顧客自己修理が任意である部品。この部品も顧客自己修理用です。当該部品について、もしもお客様がHPに交換作業を依頼される場合には、お買い上げの製品に適用される保証サービス内容の範囲内においては、費用を負担していただくことなく保証サービスを受けることができます。

<sup>3</sup>No : 除外 - HP製品の一部の部品は、顧客自己修理用ではありません。製品の保証を継続するためには、HPまたはHP正規保守代理店による交換作業が必須となります。部品カタログには、当該部品が顧客自己修理除外品である旨が記載されています。

<sup>1</sup>Mandatory: 强制性的 — 要求客户必须自行维修的部件。如果您请求 HP 更换这些部件，则必须为该服务支付差旅费和人工费用。

<sup>2</sup>Optional: 可选的 — 客户可以选择是否自行维修的部件。这些部件也是为客户自行维修设计的。不过，如果您要求 HP 为您更换这些部件，则根据为您的产品指定的保修服务类型，HP 可能收取或不再收取任何附加费用。

<sup>3</sup>No: 否 — 某些 HP 部件的设计并未考虑客户自行维修。为了满足客户保修的需要，HP 要求授权服务提供商更换相关部件。这些部件在部件图解目录中标记为“否”。

<sup>1</sup>Mandatory: 強制的 — 客戶自行維修所使用的零件是強制性的。如果您要求 HP 更換這些零件，HP 將會向您收取此服務所需的外出費用與勞動成本。

<sup>2</sup>Optional: 選購的 — 客戶自行維修所使用的零件是選購的。這些零件也設計用於客戶自行維修之用。不過，如果您要求 HP 為您更換，則可能需要也可能不需要負擔額外的費用，端視針對此產品指定的保固服務類型而定。

<sup>3</sup>No: 否 — 某些 HP 零件沒有消費者可自行維修的設計。為符合客戶保固，HP 需要授權的服務供應商更換零件。這些零件在圖示的零件目錄中，被標示為「否」。

<sup>1</sup> Mandatory: 필수 — 고객 셀프 수리가 의무 사항인 필수 부품. 사용자가 HP에 이 부품의 교체를 요청할 경우 이 서비스에 대한 출장비 및 작업비가 청구됩니다.

<sup>2</sup> Optional: 옵션 — 고객 셀프 수리가 선택 사항인 부품. 이 부품들도 고객 셀프 수리가 가능하도록 설계되었습니다. 하지만 사용자가 HP에 이 부품의 교체를 요청할 경우 사용자가 구입한 제품에 해당하는 보증 서비스 유형에 따라 추가 비용 없이 교체가 가능할 수 있습니다.

<sup>3</sup> No: No — 고객 셀프 수리가 불가능하도록 설계된 HP 부품. 이 부품들은 고객 셀프 수리가 불가능하도록 설계되었습니다. HP는 고객 보증을 만족시키기 위해 공인 서비스 제공업체를 통해 부품을 교체하도록 하고 있습니다.

# Removal and replacement procedures

## Required tools

You need the following items for some procedures:

- T-10/T-15 Torx screwdriver (included with the server)
- HP Insight Diagnostics software ("HP Insight Diagnostics" on page 61)

## Safety considerations

Before performing service procedures, review all the safety information.

### Preventing electrostatic discharge

To prevent damaging the system, be aware of the precautions you need to follow when setting up the system or handling parts. A discharge of static electricity from a finger or other conductor may damage system boards or other static-sensitive devices. This type of damage may reduce the life expectancy of the device.

To prevent electrostatic damage:

- Avoid hand contact by transporting and storing products in static-safe containers.
- Keep electrostatic-sensitive parts in their containers until they arrive at static-free workstations.
- Place parts on a grounded surface before removing them from their containers.
- Avoid touching pins, leads, or circuitry.
- Always be properly grounded when touching a static-sensitive component or assembly.

### Server warnings and cautions

Before installing a server, be sure that you understand the following warnings and cautions.



**WARNING:** To reduce the risk of electric shock or damage to the equipment:

- Do not disable the power cord grounding plug. The grounding plug is an important safety feature.
- Plug the power cord into a grounded (earthed) electrical outlet that is easily accessible at all times.
- Unplug the power cord from the power supply to disconnect power to the equipment.
- Do not route the power cord where it can be walked on or pinched by items placed against it. Pay particular attention to the plug, electrical outlet, and the point where the cord extends from the server.



**WARNING:** To reduce the risk of personal injury from hot surfaces, allow the drives and the internal system components to cool before touching them.



**CAUTION:** Do not operate the server for long periods with the access panel open or removed. Operating the server in this manner results in improper airflow and improper cooling that can lead to thermal damage.

## Preparation procedures

To access some components and perform certain service procedures, you must perform one or both of the following procedures:

- Power down the server (on page 24).  
If you must remove a server from a rack or a non-hot-plug component from a server, power down the server.
- Remove the server from the rack (on page 24).  
If the rack environment, cabling configuration, or the server location in the rack creates awkward conditions, remove the server from the rack.

## Power down the server

Before powering down the server for any upgrade or maintenance procedures, perform a backup of critical server data and programs.



**WARNING:** To reduce the risk of personal injury, electric shock, or damage to the equipment, remove the power cord to remove power from the server. The front panel Power On/Standby button does not completely shut off system power. Portions of the power supply and some internal circuitry remain active until AC/DC power is removed.



**IMPORTANT:** When the server is in standby mode, auxiliary power is still being provided to the system.

To power down the server, use one of the following methods:

- Press and release the Power On/Standby button.  
This method initiates a controlled shutdown of applications and the OS before the server enters standby mode.
- Press and hold the Power On/Standby button for more than 4 seconds to force the server to enter standby mode.  
This method forces the server to enter standby mode without properly exiting applications and the OS. If an application stops responding, you can use this method to force a shutdown.
- Use a virtual power button selection through iLO.  
This method initiates a controlled remote shutdown of applications and the OS before the server enters standby mode.

Before proceeding, verify the server is in standby mode by observing that the system power LED is amber.

## Remove the server from the rack



**WARNING:** The server is not attached to the rack mounting rails. To avoid potential damage to the server and personal injury, always support the server with both hands when removing it from the rack.

To remove the server from an HP, Compaq branded, TELCO, or third-party rack:

1. Power down the server (on page 24).
2. Disconnect all peripheral cables and power cords from the server rear panel.
3. Loosen the thumbscrews that secure the server faceplate to the front of the rack.
4. Remove the server from the rack. For more information, see the documentation that ships with the rack mounting option.
5. Place the server on a sturdy, level surface.

## Access panel



**WARNING:** To reduce the risk of personal injury from hot surfaces, allow the drives and the internal system components to cool before touching them.



**CAUTION:** For proper cooling, do not operate the server without the access panel, baffles, expansion slot covers, or blanks installed. If the server supports hot-plug components, minimize the amount of time the access panel is open.

To remove the component:

1. Power down the server (on page 24).
2. Remove the server from the rack (on page 24).
3. Press the hood latch button, slide the access panel to the rear of the chassis, and then remove the access panel.

If the access panel is locked, use a T-10 Torx screwdriver to unlock the hood lock screw.

To replace the component, reverse the removal procedure.

## Air baffle

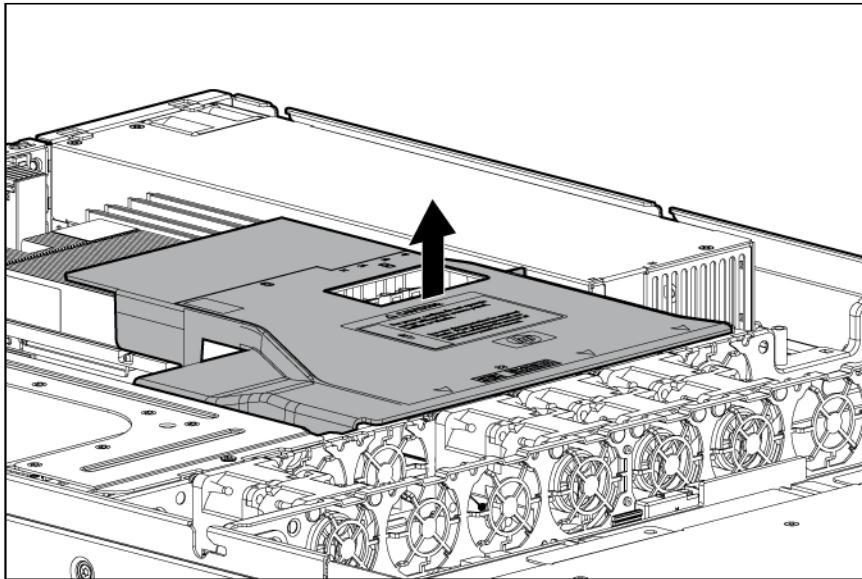


**CAUTION:** For proper cooling, do not operate the server without the access panel, baffles, expansion slot covers, or blanks installed. If the server supports hot-plug components, minimize the amount of time the access panel is open.

To remove the component:

1. Power down the server (on page 24).
2. Remove the access panel ("Access panel" on page 25).

3. Remove the air baffle.



To replace the component, reverse the removal procedure.

## PCIe riser cage

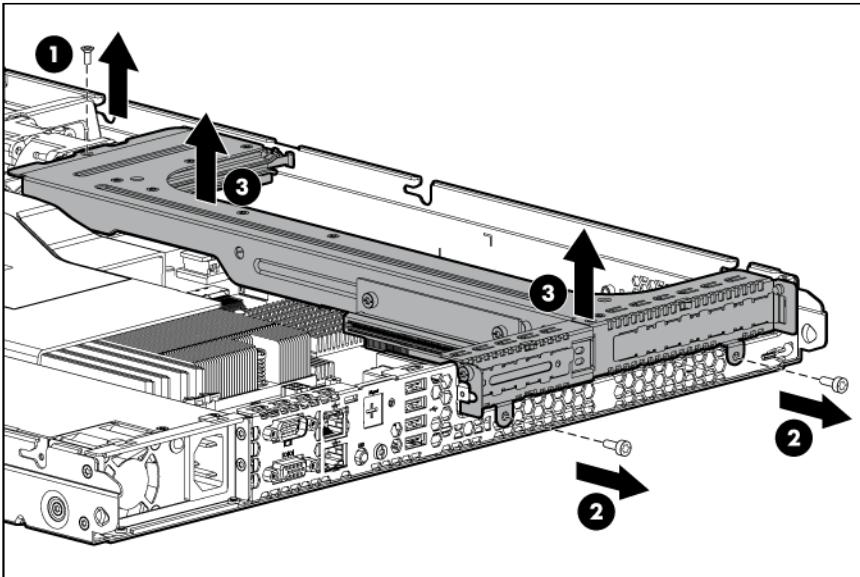


**CAUTION:** To prevent damage to the server or expansion boards, power down the server and remove all AC power cords before removing or installing the PCIe riser board assembly.

To remove the component:

1. Power down the server (on page 24).
2. Remove the server from the rack (on page 24).
3. Remove the access panel ("Access panel" on page 25).
4. Disconnect all internal cables connected to existing expansion boards.
5. Remove the PCIe riser cage:
  - a. Remove the T-10 screw.
  - b. Remove the T-15 screws.

- c. Remove the riser cage.



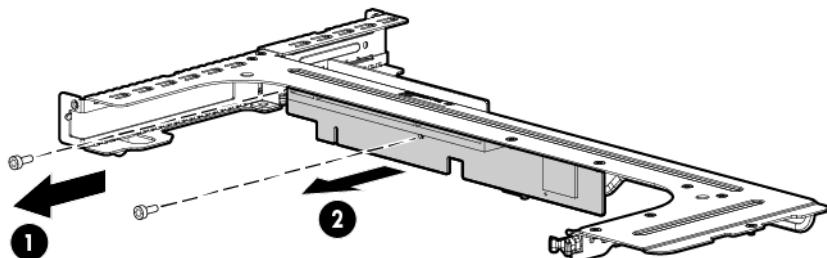
To replace the component, reverse the removal procedure.

## PCIe riser board

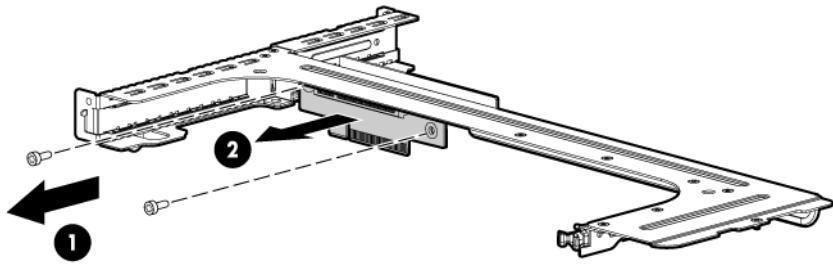
**CAUTION:** To prevent damage to the server or expansion boards, power down the server and remove all AC power cords before removing or installing the PCIe riser board assembly.

To remove the component:

1. Power down the server (on page 24).
2. Remove all power:
  - a. Disconnect each power cord from the power source.
3. Remove the server from the rack (on page 24).
4. Remove the access panel ("Access panel" on page 25).
5. Remove the PCIe riser cage ("PCIe riser cage" on page 26).
6. Remove any installed expansion boards ("Expansion board" on page 35).
7. Remove the PCIe riser board:
  - o Full-length riser board



- Low-profile riser board



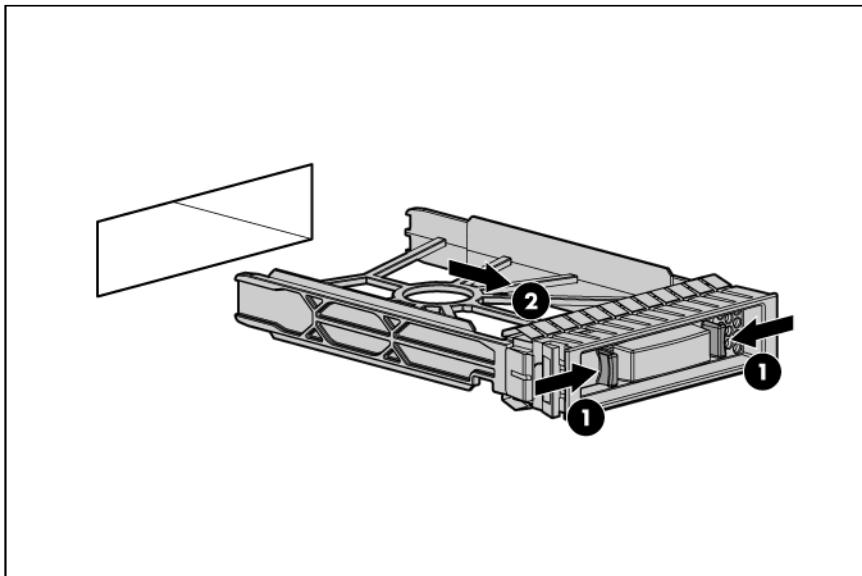
To replace the component, reverse the removal procedure.

## Drive blank



**CAUTION:** To prevent improper cooling and thermal damage, do not operate the server unless all bays are populated with either a component or a blank.

Remove the component as indicated.



To replace the component, reverse the removal procedure.

## Hot-plug drive



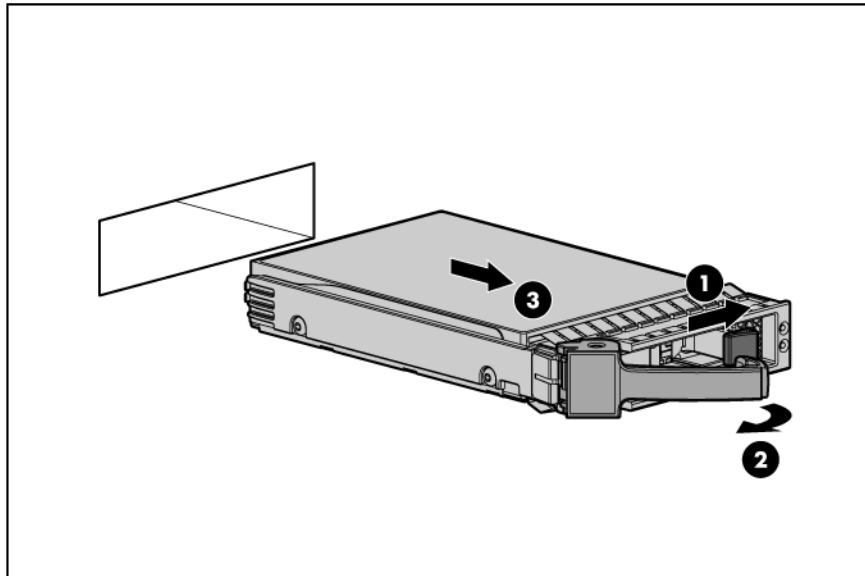
**IMPORTANT:** Hot-plug capability and drive LED support are only available when a supported optional controller is installed in the server.

To remove the component:

1. Back up all data on the drive.
2. Power down the server (on page 24).

**⚠ CAUTION:** To prevent improper cooling and thermal damage, do not operate the server unless all bays are populated with either a component or a blank.

3. Remove the drive.



**⚠ WARNING:** To reduce the risk of injury from electric shock, do not remove more than one drive carrier at a time.

To replace the component, reverse the removal procedure.

## Redundant hot-plug power supply

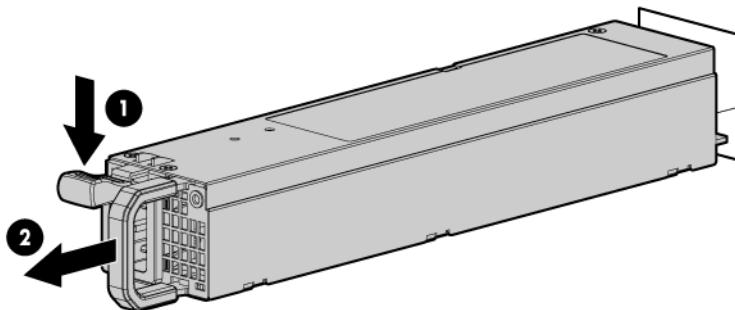
**⚠ WARNING:** To reduce the risk of personal injury from hot surfaces, allow the power supply or power supply blank to cool before touching it.

**⚠ CAUTION:** To prevent improper cooling and thermal damage, do not operate the server unless all bays are populated with either a component or a blank.

To remove the component:

1. Determine how many hot-plug power supplies are installed:
  - o If only one hot-plug power supply is installed, power down the server (on page 24).
  - o If more than one hot-plug power supply is installed, continue with the next step.
2. Disconnect the power cord from the source.
3. Remove the power cord from the power supply.

4. Remove the power supply from the server.



**⚠ WARNING:** To reduce the risk of electric shock or damage to the equipment, do not connect the power cord to the power supply until the power supply is installed.

To replace the component, reverse the removal procedure.

## Redundant hot-plug power supply backplane

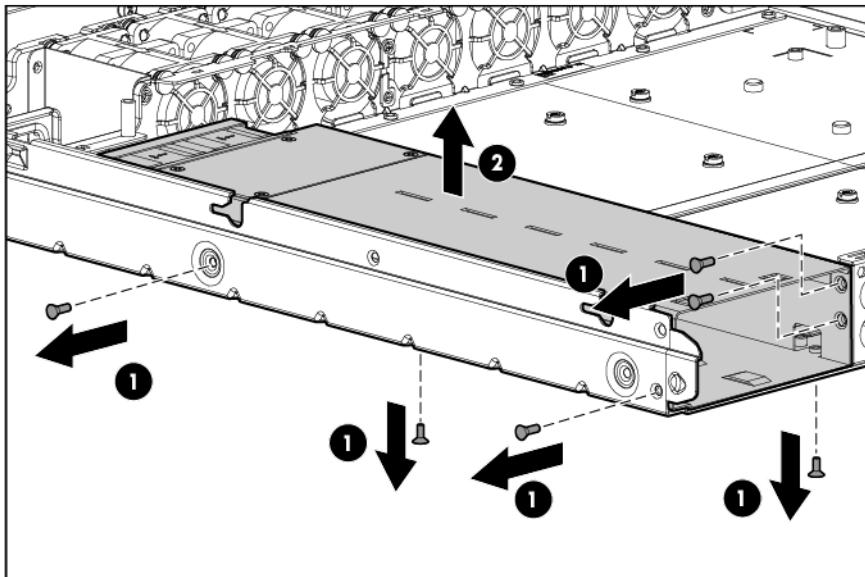
**⚠ WARNING:** To reduce the risk of personal injury from hot surfaces, allow the power supply or power supply blank to cool before touching it.

**⚠ CAUTION:** To prevent improper cooling and thermal damage, do not operate the server unless all bays are populated with either a component or a blank.

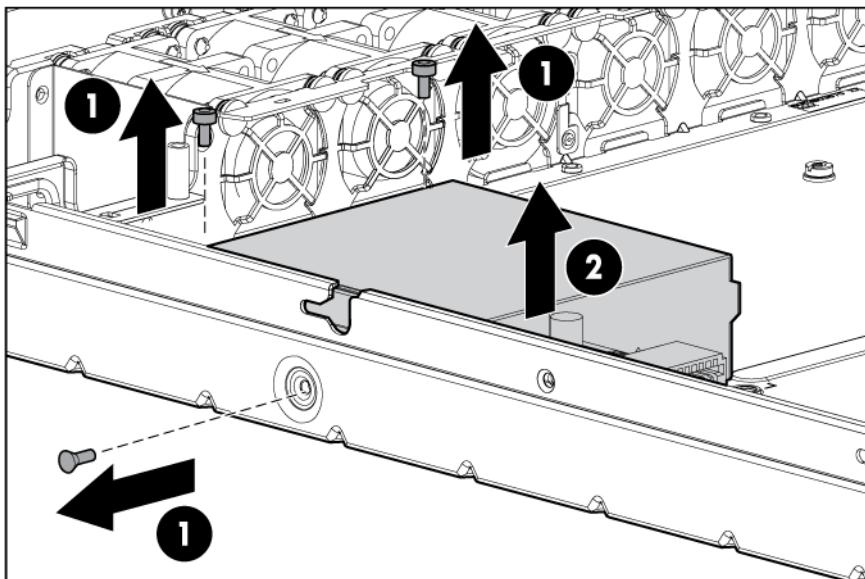
To remove the component:

1. Power down the server (on page 24).
2. Remove the redundant hot-plug power supplies ("Redundant hot-plug power supply" on page 29).
3. Remove the server from the rack (on page 24).
4. Remove the access panel ("Access panel" on page 25).
5. Remove the air baffle ("Air baffle" on page 25).
6. Disconnect the power supply cables.  
For more information, see "Redundant power supply cabling (on page 56)".
7. Remove the system board ("System board" on page 48).

8. Remove the power supply cage.



9. Remove the power supply cage backplane.



To replace the component, reverse the removal procedure.

## Nonredundant power supply bracket

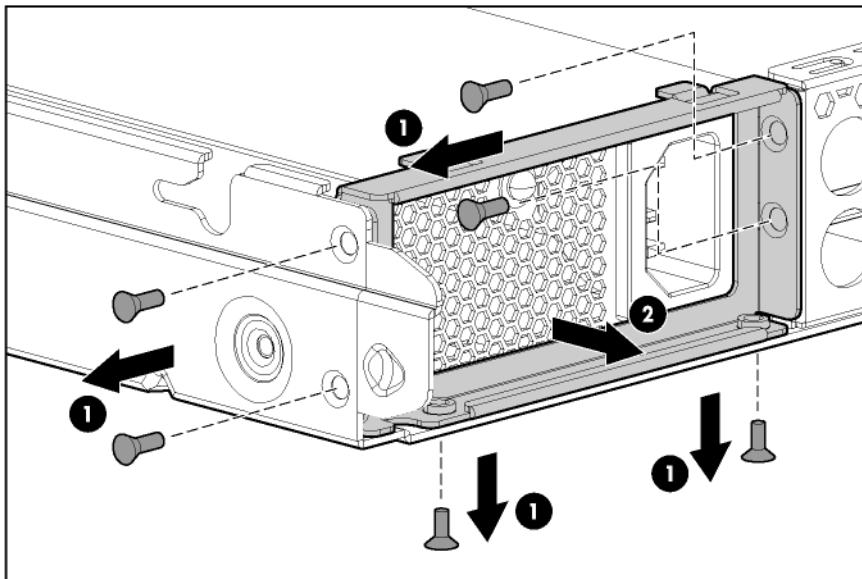
**⚠ WARNING:** To reduce the risk of personal injury from hot surfaces, allow the power supply or power supply blank to cool before touching it.

**⚠ CAUTION:** To prevent improper cooling and thermal damage, do not operate the server unless all bays are populated with either a component or a blank.

To remove the component:

1. Power down the server (on page 24).

2. Remove the server from the rack (on page 24).
3. Remove the access panel ("Access panel" on page 25).
4. Remove the power supply bracket.



To replace the component, reverse the removal procedure.

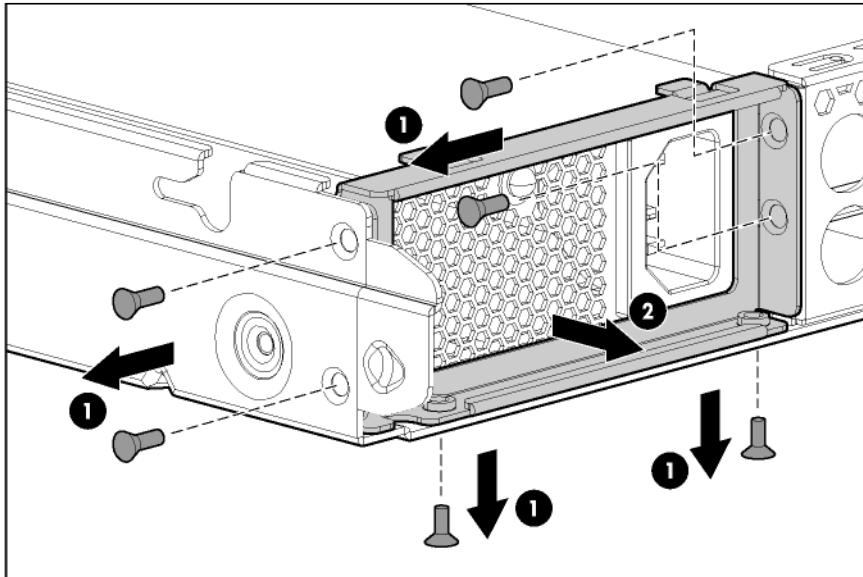
## Nonredundant power supply

- 
- ⚠ WARNING:** To reduce the risk of personal injury from hot surfaces, allow the power supply or power supply blank to cool before touching it.
- 
- ⚠ CAUTION:** To prevent improper cooling and thermal damage, do not operate the server unless all bays are populated with either a component or a blank.
- 

To remove the component:

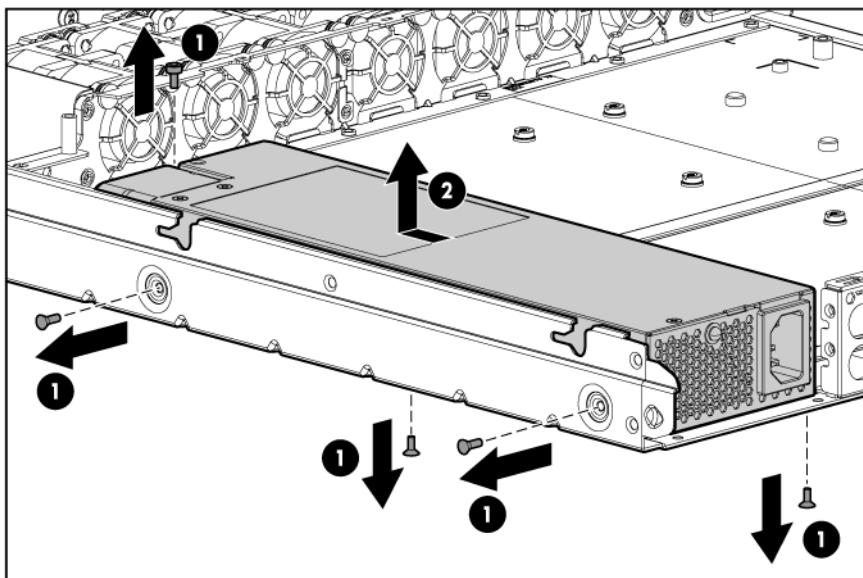
1. Power down the server (on page 24).
2. Disconnect the power cord from the source.
3. Disconnect the power cord from the power supply.
4. Remove the server from the rack (on page 24).
5. Remove the access panel ("Access panel" on page 25).
6. Remove the air baffle ("Air baffle" on page 25).
7. Disconnect the power supply cables. For more information, see "Nonredundant power supply cabling (on page 55)".

8. Remove the power supply bracket.



9. Remove the system board ("System board" on page 48).

10. Remove the power supply.



**WARNING:** To reduce the risk of electric shock or damage to the equipment, do not connect the power cord to the power supply until the power supply is installed.

To replace the component, reverse the removal procedure.

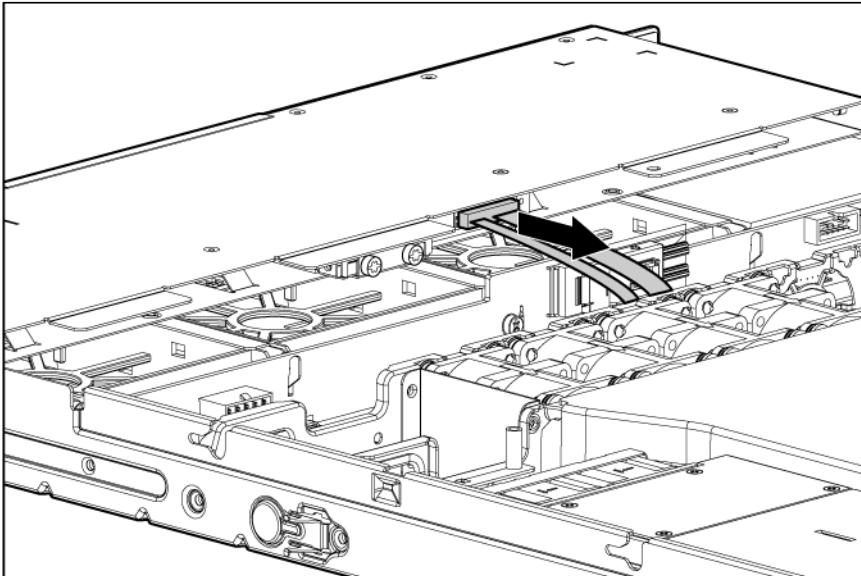
## Optical drive



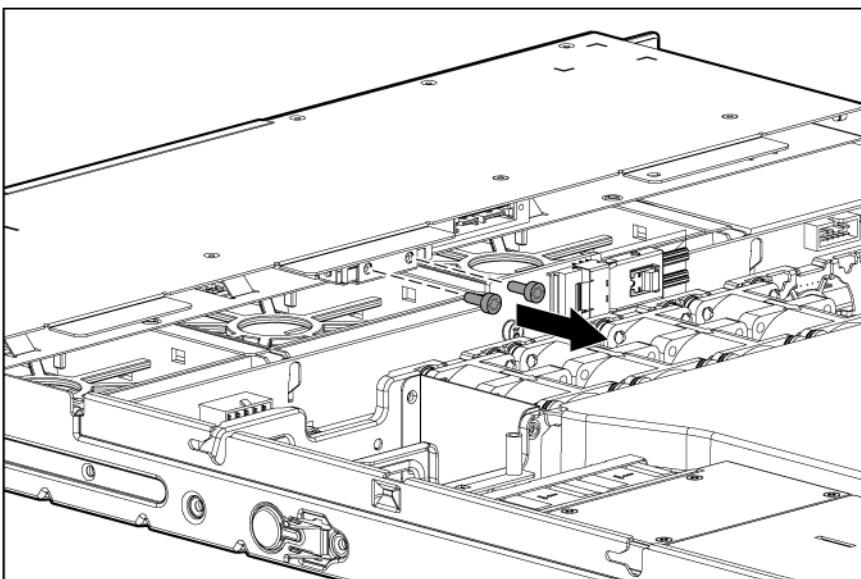
**CAUTION:** To prevent improper cooling and thermal damage, do not operate the server unless all bays are populated with either a component or a blank.

To remove the component:

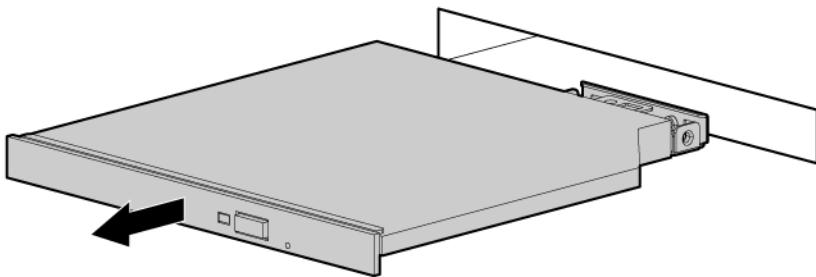
1. Power down the server (on page 24).
2. Remove the server from the rack (on page 24).
3. Remove the access panel ("Access panel" on page 25).
4. Disconnect the cables from the optical drive.



5. Remove the optical drive screws.



6. Remove the optical drive assembly.

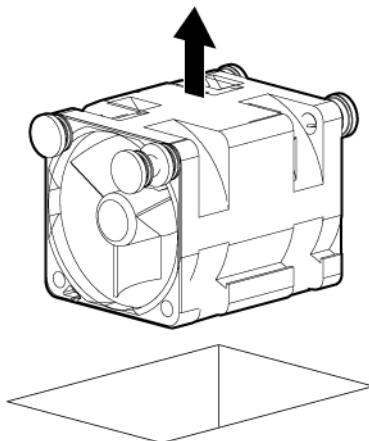


To replace the component, reverse the removal procedure.

## Fan

To remove the component:

1. Power down the server (on page 24).
2. Remove the server from the rack (on page 24).
3. Remove the access panel ("Access panel" on page 25).
4. Remove the air baffle ("Air baffle" on page 25).
5. Disconnect the fan cable from the system board.
6. Remove the fan.



To replace the component, reverse the removal procedure.

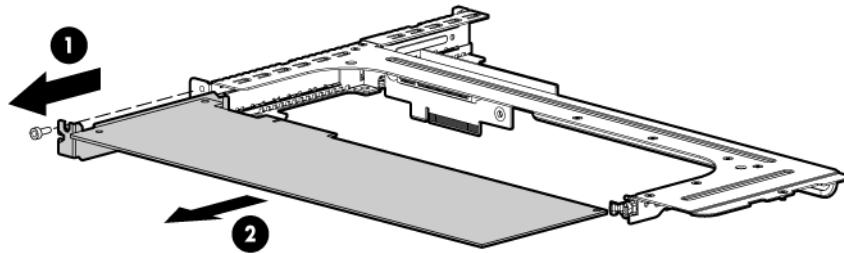
## Expansion board



**CAUTION:** To prevent damage to the server or expansion boards, power down the server and remove all AC power cords before removing or installing the PCIe riser board assembly.

To remove the component:

1. Power down the server (on page 24).
2. Remove the server from the rack (on page 24).
3. Remove the access panel ("Access panel" on page 25).
4. Disconnect all internal cables connected to installed expansion boards.
5. Remove the PCIe riser cage ("PCIe riser cage" on page 26).
6. Remove the expansion board.

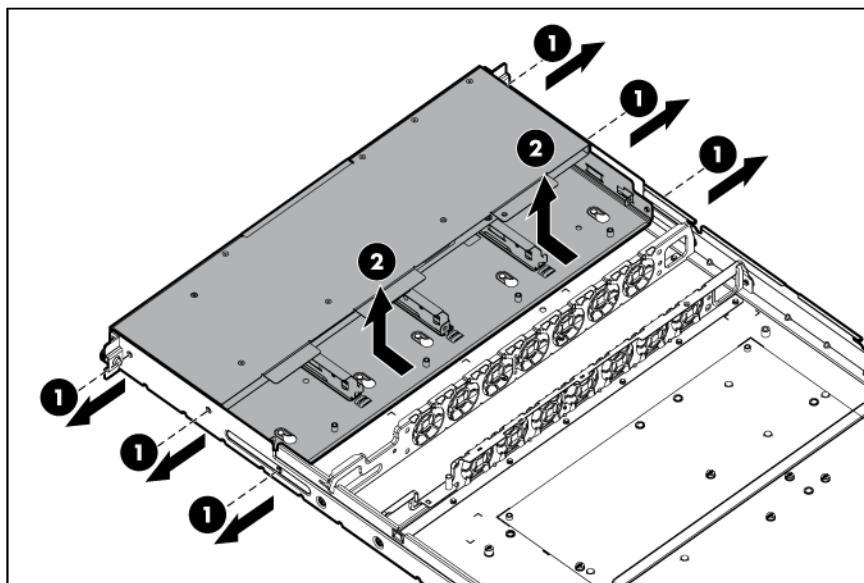


To replace the component, reverse the removal procedure.

## Drive cage

To remove the component:

1. Power down the server (on page 24).
2. Remove the server from the rack (on page 24).
3. Remove the access panel ("Access panel" on page 25).
4. Remove all drives ("Hot-plug drive" on page 28).
5. Disconnect all cables from the drive backplane.
6. Remove the drive cage.



To replace the component, reverse the removal procedure.

## Battery-backed write cache procedures

Removing and replacing failed components by:

- Removing the cache module ("BBWC module" on page 37)
- Recovering data from the battery-backed write cache (on page 39)

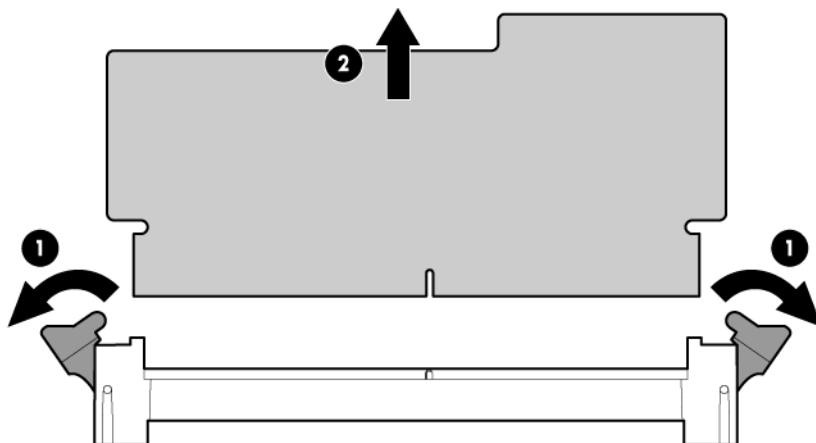


**CAUTION:** Do not detach the cable that connects the battery pack to the cache module. Detaching the cable causes any unsaved data in the cache module to be lost.

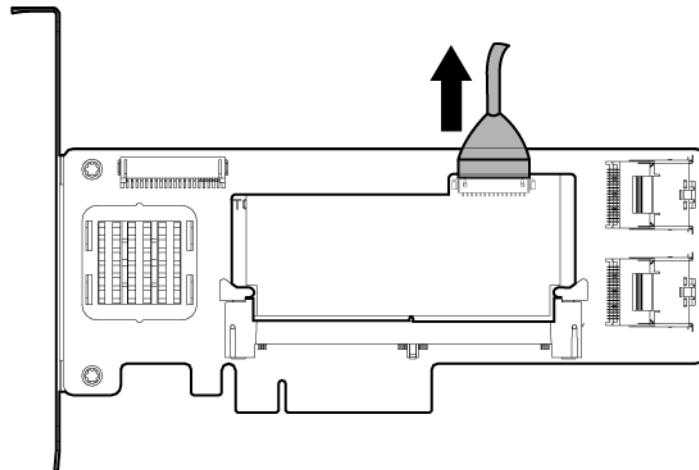
### BBWC module

To remove the component:

1. Power down the server (on page 24).
2. Remove the server from the rack (on page 24).
3. Remove the access panel ("Access panel" on page 25).
4. Remove the air baffle ("Air baffle" on page 25).
5. Remove the PCIe riser cage ("PCIe riser cage" on page 26).
6. Remove the expansion board ("Expansion board" on page 35).
7. Remove the BBWC module.



8. If the BBWC module is connected to a battery pack, disconnect the battery pack cable from the connector on the top of the cache module.



**CAUTION:** To prevent damage to the cache module during installation, be sure the cache module is fully inserted before pressing down.

To replace the component, reverse the removal procedure.

## BBWC battery pack

To remove the component:

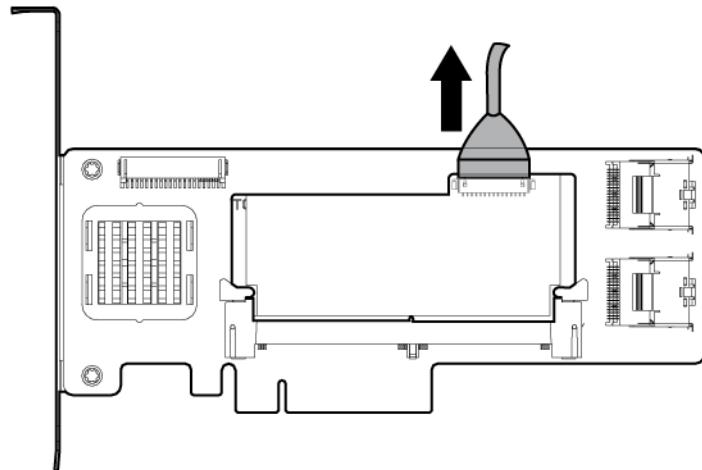
1. Back up all data.
2. Close all applications.
3. Power down the server (on page 24).



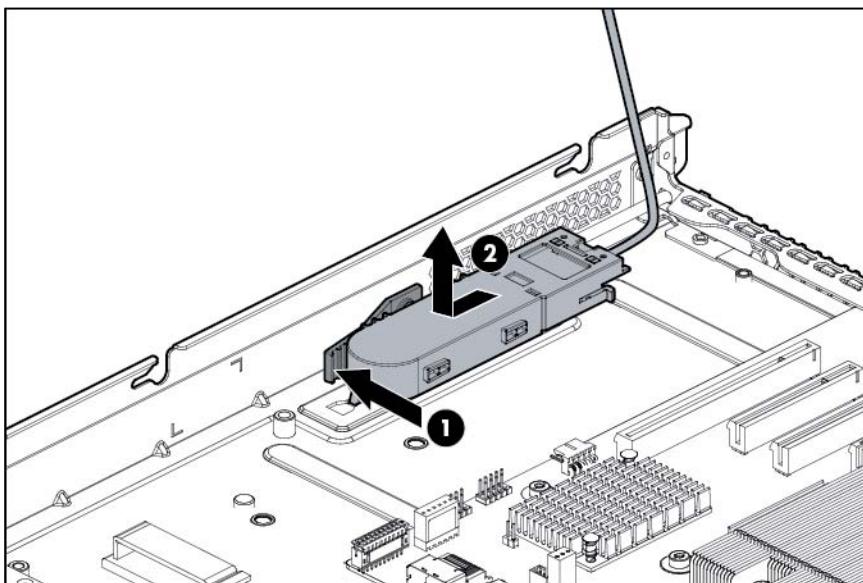
**CAUTION:** In systems that use external data storage, be sure that the server is the first unit to be powered down and the last to be powered back up. Taking this precaution ensures that the system does not erroneously mark the drives as failed when the server is powered up.

4. Remove the access panel ("Access panel" on page 25).
5. Remove the air baffle ("Air baffle" on page 25).
6. Remove the PCIe riser cage ("PCIe riser cage" on page 26).

7. If the battery pack is connected to the BBWC module, disconnect the battery pack cable from the connector on the top of the cache module.



8. Disconnect the cable, and then remove the battery pack.



## Recovering data from the battery-backed write cache

If the server fails, use the following procedure to recover data temporarily stored in the BBWC.

**CAUTION:** Before starting this procedure, read the information about protecting against electrostatic discharge ("[Preventing electrostatic discharge](#)" on page 23).

1. Perform one of the following:
  - Set up a recovery server station using an identical server model. Do not install any internal drives or BBWC in this server. (HP recommends this option.)
  - Find a server that has enough empty drive bays to accommodate all the drives from the failed server and that meets all the other requirements for drive and array migration.

2. Power down the failed server ("Power down the server" on page 24). If any data is stored in the cache module, a green LED on the module flashes every 2 seconds.

 **CAUTION:** Do not detach the cable that connects the battery pack to the cache module. Detaching the cable causes any unsaved data in the cache module to be lost.

3. Transfer the hard drives from the failed server to the recovery server station.
4. Perform one of the following:
  - o If the array controller has failed, remove the cache module ("BBWC module" on page 37) and battery pack from the failed array controller, and install the cache module and battery pack on an array controller in the recovery server.
  - o If the server has failed, remove the controller, cache module ("BBWC module" on page 37), and battery pack from the failed server, and install the controller, cache module, and battery pack in the recovery server.
5. Power up the recovery server. A 1759 POST message is displayed, stating that valid data was flushed from the cache. This data is now stored on the drives in the recovery server. You can now transfer the drives (and controller, if one was used) to another server.

## System battery

If the server no longer automatically displays the correct date and time, you might have to replace the battery that provides power to the real-time clock.

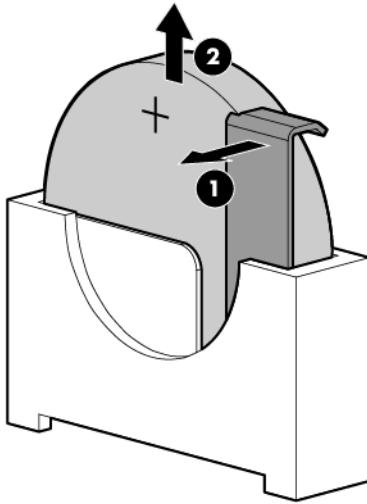


**WARNING:** The computer contains an internal lithium manganese dioxide, a vanadium pentoxide, or an alkaline battery pack. A risk of fire and burns exists if the battery pack is not properly handled. To reduce the risk of personal injury:

- Do not attempt to recharge the battery.
- Do not expose the battery to temperatures higher than 60°C (140°F).
- Do not disassemble, crush, puncture, short external contacts, or dispose of in fire or water.
- Replace only with the spare designated for this product.

1. Power down the server (on page 24).
2. Remove the access panel ("Access panel" on page 25).

3. Remove the battery.



To replace the component, reverse the removal procedure.

For more information about battery replacement or proper disposal, contact an authorized reseller or an authorized service provider.

## HP Trusted Platform Module

The TPM is not a customer-removable part.

---

**CAUTION:** Any attempt to remove an installed TPM from the system board breaks or disfigures the TPM security rivet. Upon locating a broken or disfigured rivet on an installed TPM, administrators should consider the system compromised and take appropriate measures to ensure the integrity of the system data.

---

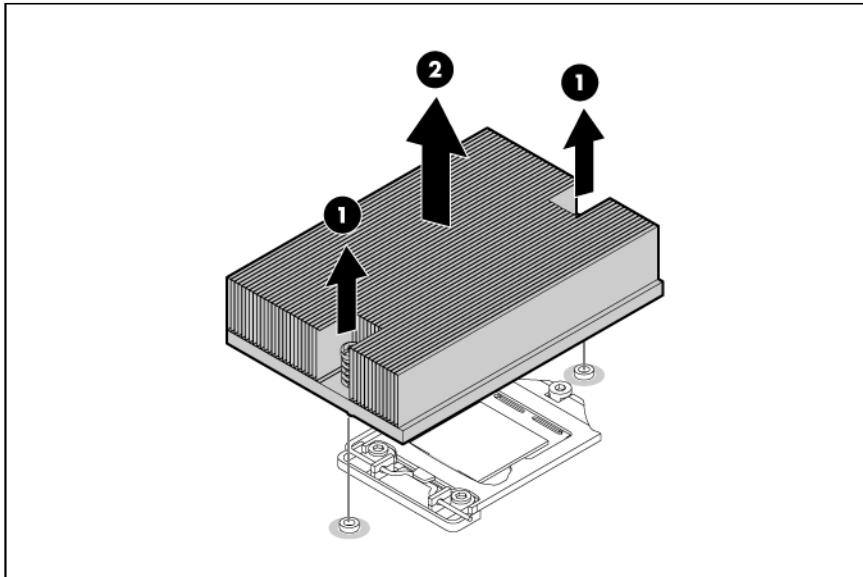
If you suspect a TPM board failure, leave the TPM installed and remove the system board ("System board" on page 48). Contact an HP authorized service provider for a replacement system board and TPM board.

## Heatsink

To remove the component:

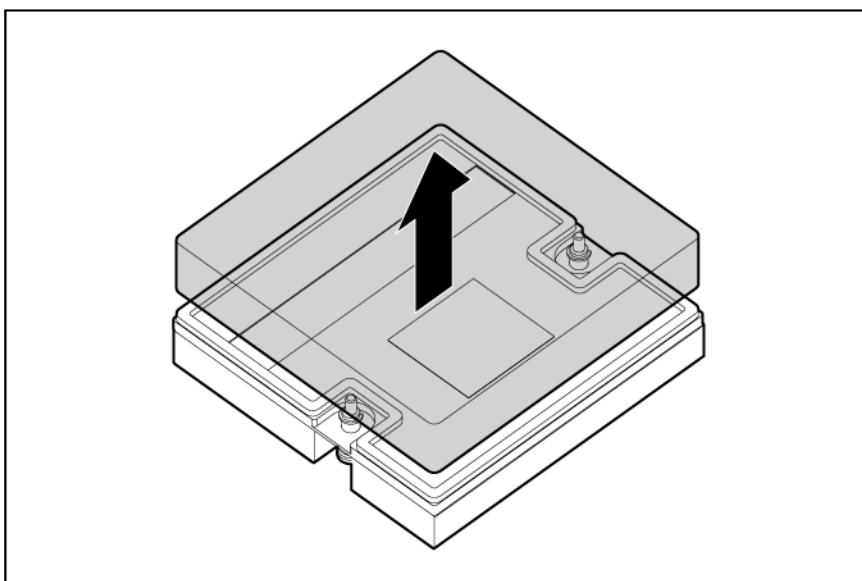
1. Power down the server (on page 24).
2. Remove all power:
  - a. Disconnect each power cord from the power source.
  - b. Disconnect each power cord from the server.
3. Remove the server from the rack (on page 24).
4. Remove the access panel ("Access panel" on page 25).
5. Remove the air baffle ("Air baffle" on page 25).

6. Loosen the two screws, and then remove the heatsink.

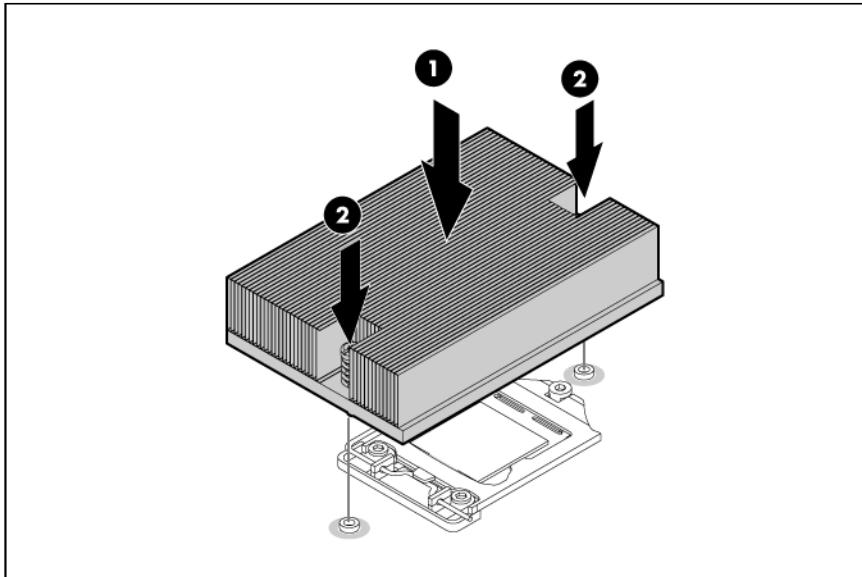


To replace the component:

1. Clean the old thermal grease from the processor with the alcohol swab. Allow the alcohol to evaporate before continuing.
2. Remove the protective cover from the bottom of the heatsink.



3. Install the heatsink, and then insert and tighten the two screws.



4. Install the air baffle.
5. Install the access panel.
6. Install the server into the rack.
7. Power on the server.

## Processor



**CAUTION:** To avoid damage to the processor and system board, only authorized personnel should attempt to replace or install the processor in this server.

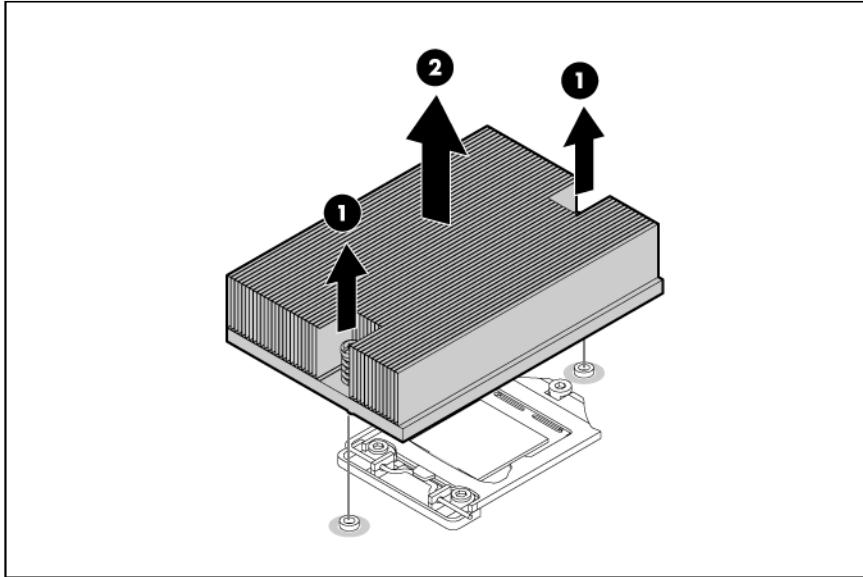


**IMPORTANT:** If installing a processor with a faster speed, update the system ROM before installing the processor.

To remove the component:

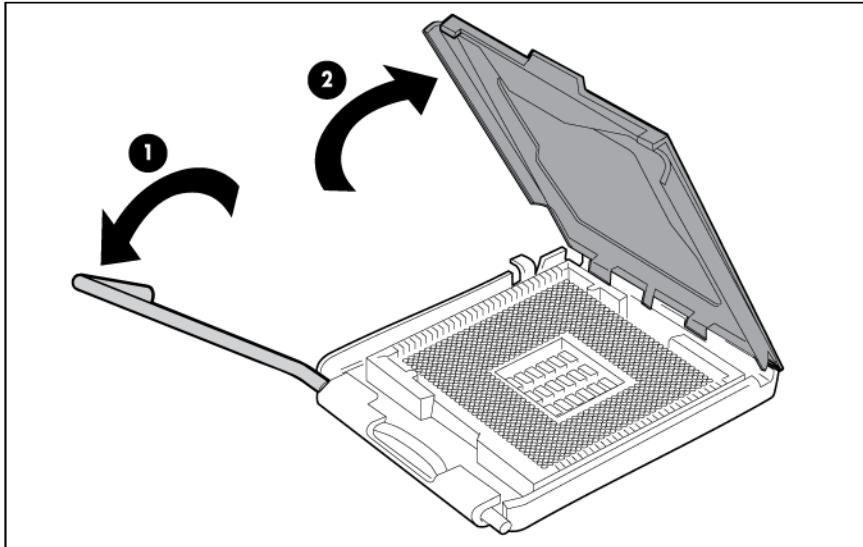
1. Power down the server (on page 24).
2. Remove all power:
  - a. Disconnect each power cord from the power source.
  - b. Disconnect each power cord from the server.
3. Remove the server from the rack (on page 24).
4. Remove the access panel ("Access panel" on page 25).
5. Remove the air baffle ("Air baffle" on page 25).

6. Remove the two screws, and then remove the heatsink.

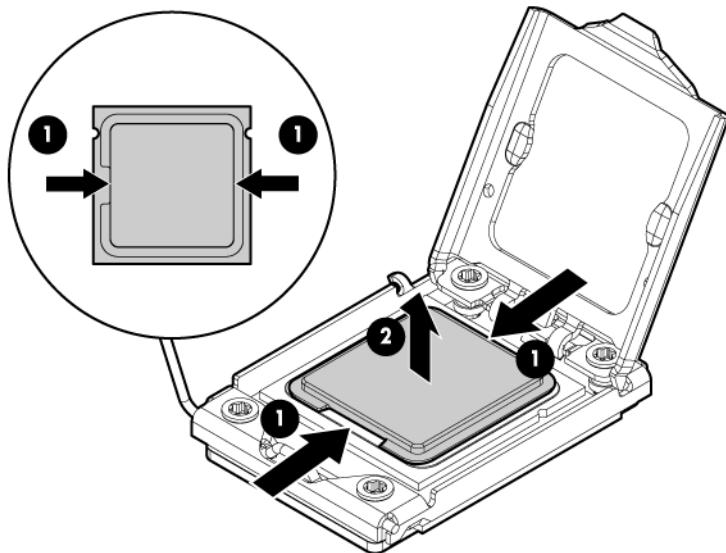


△ **CAUTION:** Failure to completely open the processor locking lever prevents the processor from seating during installation, leading to hardware damage.

7. Open the processor retaining latch and the processor socket retaining bracket.



8. Carefully lift the processor straight out of the socket.



To replace the component:

1. Install the processor.



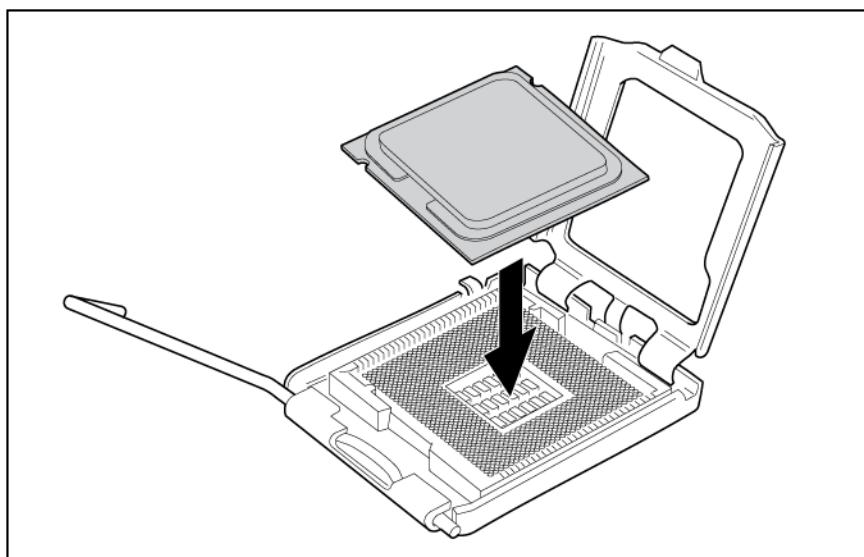
**CAUTION:** To avoid damage to the processor:

- Handle the processor only by the edges.
- Do not touch the bottom of the processor, especially the contact area.



**CAUTION: THE PINS ON THE SYSTEM BOARD ARE VERY FRAGILE AND EASILY DAMAGED.** To avoid damage to the system board:

- Do not touch the processor socket contacts.
- Do not tilt or slide the processor when lowering the processor into the socket.

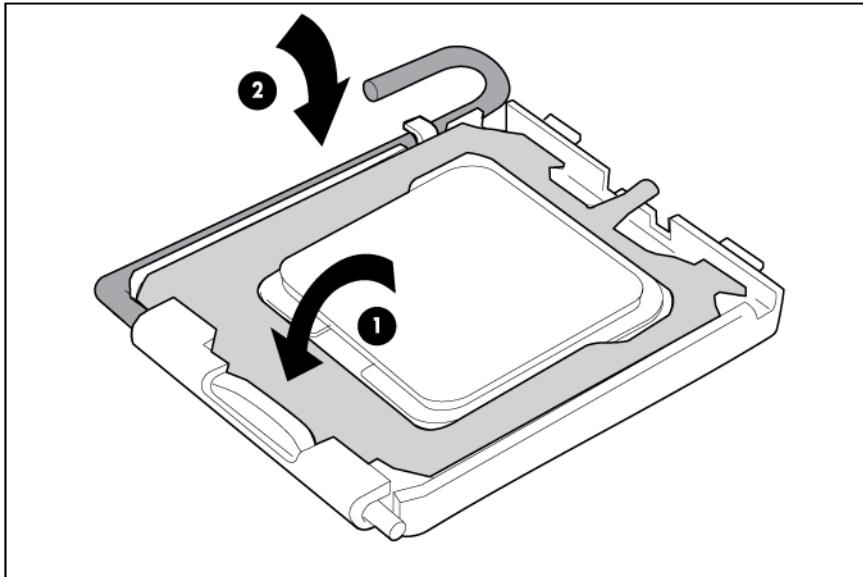


2. Close the processor retaining bracket and the processor retaining latch.

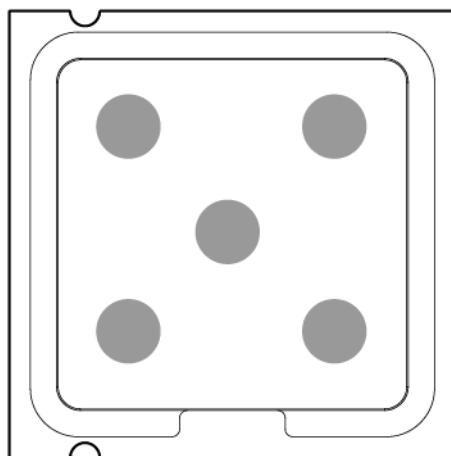
**CAUTION:** Be sure to close the processor socket retaining bracket before closing the processor locking lever. The lever should close without resistance. Forcing the lever closed can damage the processor and socket, requiring system board replacement.

**CAUTION:** To avoid damage to the system board:

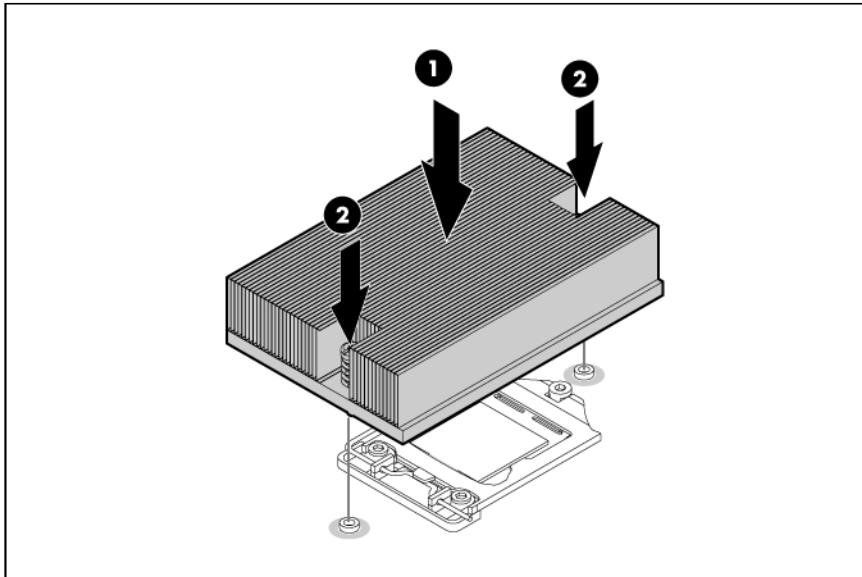
- Do not touch the processor socket contacts.
- Always install the processor socket cover after removing the processor from the socket.
- Do not tilt or slide the processor when lowering the processor into the socket.



3. Clean the old thermal grease from the bottom of the heatsink with the alcohol swab. Allow the alcohol to evaporate before continuing.
4. Apply all the grease to the top of the processor in the following pattern to ensure even distribution.



5. Install the heatsink, and then insert and tighten the two screws.



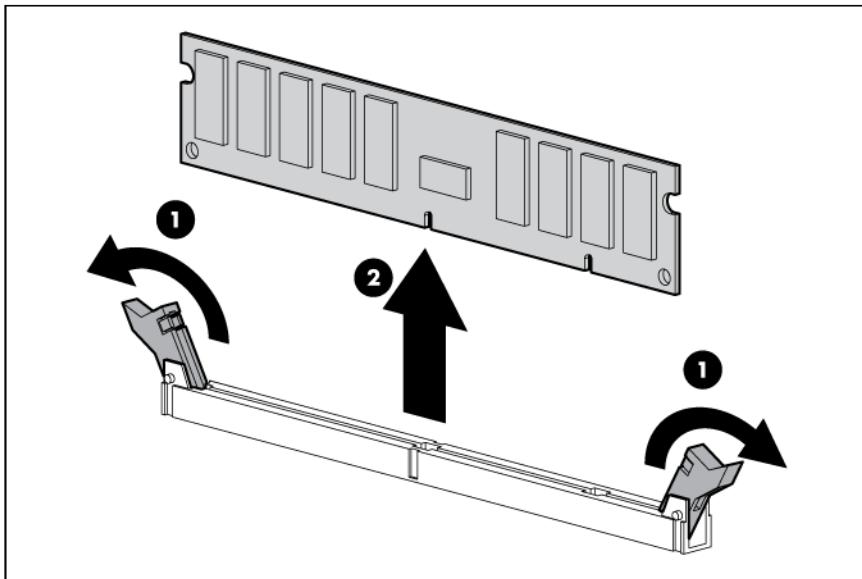
6. Install the air baffle.
7. Install the access panel.
8. Install the server into the rack.
9. Power on the server.

## DIMM

To remove the component:

1. Power down the server (on page 24).
2. Remove all power:
  - a. Disconnect each power cord from the power source.
  - b. Disconnect each power cord from the server.
3. Do one of the following:
  - o Extend the server from the rack.
  - o Remove the server from the rack (on page 24).
4. Remove the access panel ("Access panel" on page 25).
5. Remove the air baffle ("Air baffle" on page 25).
6. Open the DIMM slot latches.

7. Remove the DIMM.



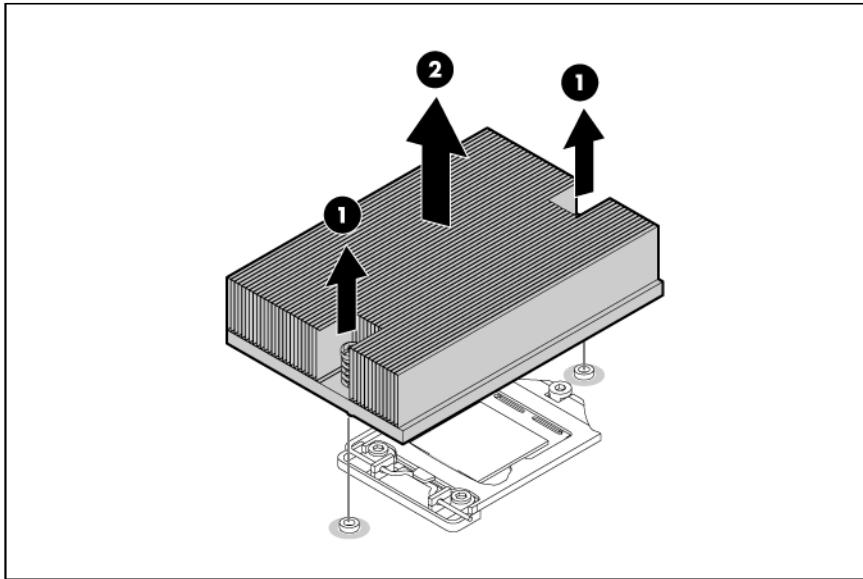
To replace the component, reverse the removal procedure.

## System board

To remove the component:

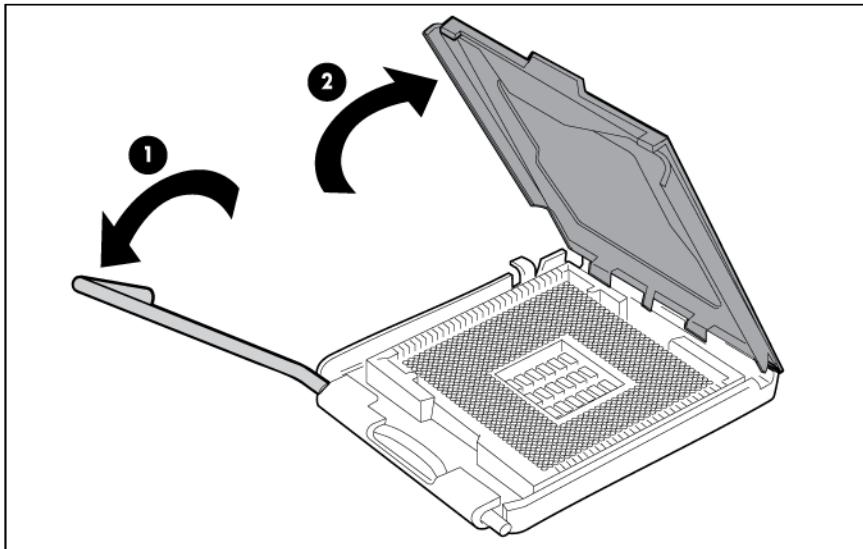
1. Power down the server (on page 24).
2. Remove all power:
  - a. Disconnect each power cord from the power source.
  - b. Disconnect each power cord from the server.
3. Remove the server from the rack (on page 24).
4. Remove the access panel ("Access panel" on page 25).
5. Remove the air baffle ("Air baffle" on page 25).
6. Remove the PCIe riser cage ("PCIe riser cage" on page 26).
7. Remove the battery pack ("BBWC battery pack" on page 38).
8. Remove all DIMMs ("DIMM" on page 47).
9. Disconnect all cables connected to the system board.

10. Loosen the two screws, and then remove the heatsink.

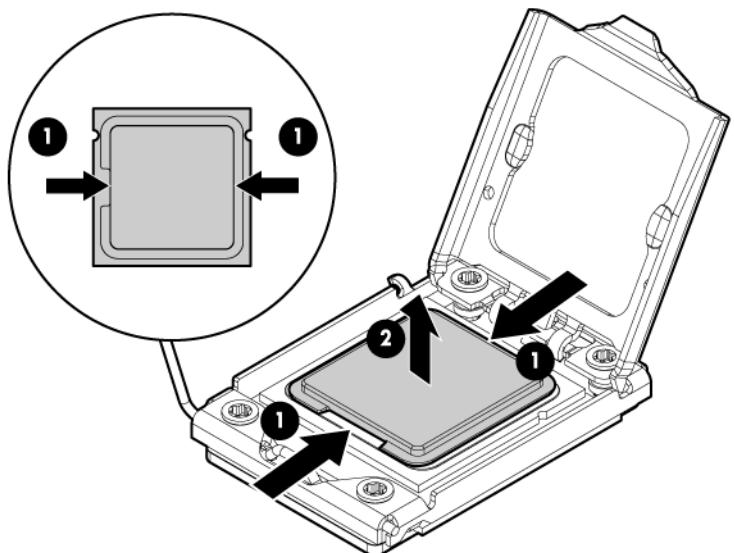


△ **CAUTION:** Failure to completely open the processor locking lever prevents the processor from seating during installation, leading to hardware damage.

11. Open the processor retaining latch and the processor socket retaining bracket.

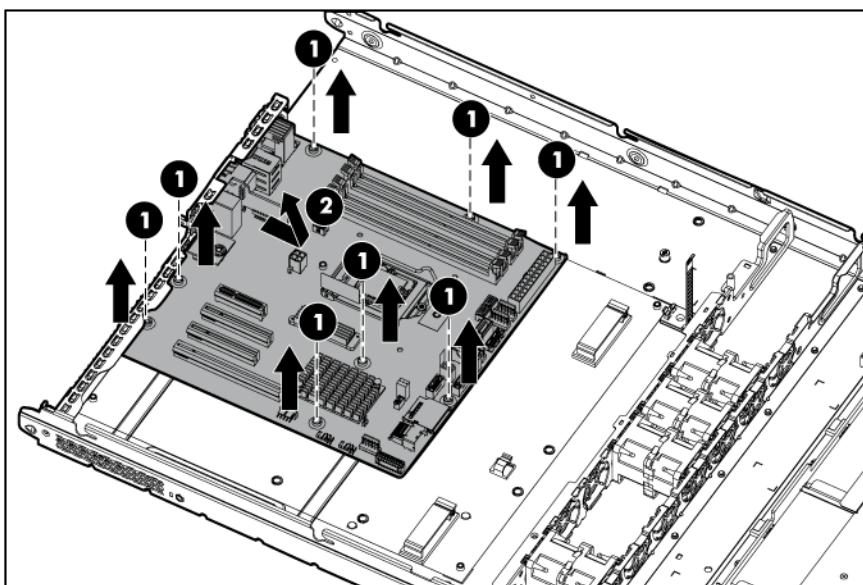


**12.** Carefully lift the processor straight out of the socket.



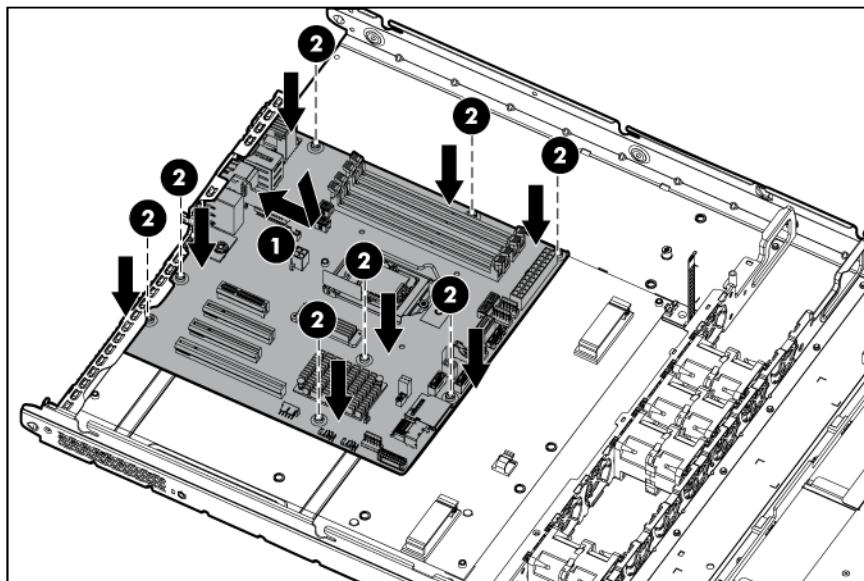
**13.** Remove the system board screws.

**14.** Remove the system board.



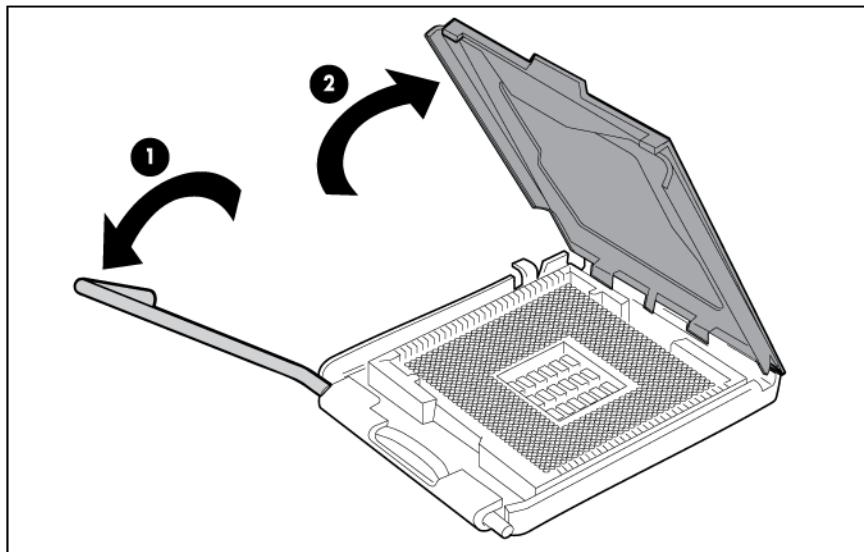
To replace the component:

1. Install the spare system board.



**CAUTION:** Failure to completely open the processor locking lever prevents the processor from seating during installation, leading to hardware damage.

2. Open the processor retaining latch and the processor socket retaining bracket.



3. Remove the plastic protective cover from the processor socket.

4. Install the processor.

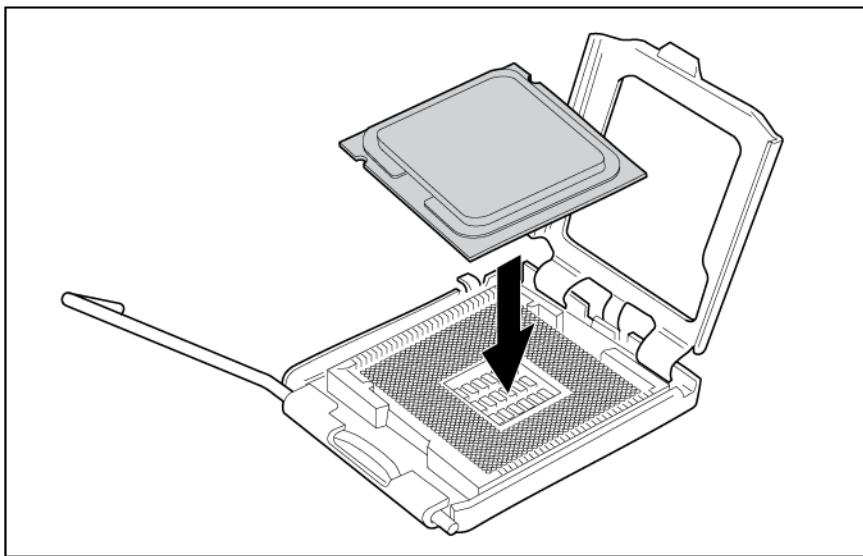
**CAUTION:** To avoid damage to the processor:

- Handle the processor only by the edges.
- Do not touch the bottom of the processor, especially the contact area.

**CAUTION: THE PINS ON THE SYSTEM BOARD ARE VERY FRAGILE AND EASILY DAMAGED.** To avoid damage to the system board:

- Do not touch the processor socket contacts.

- Do not tilt or slide the processor when lowering the processor into the socket.

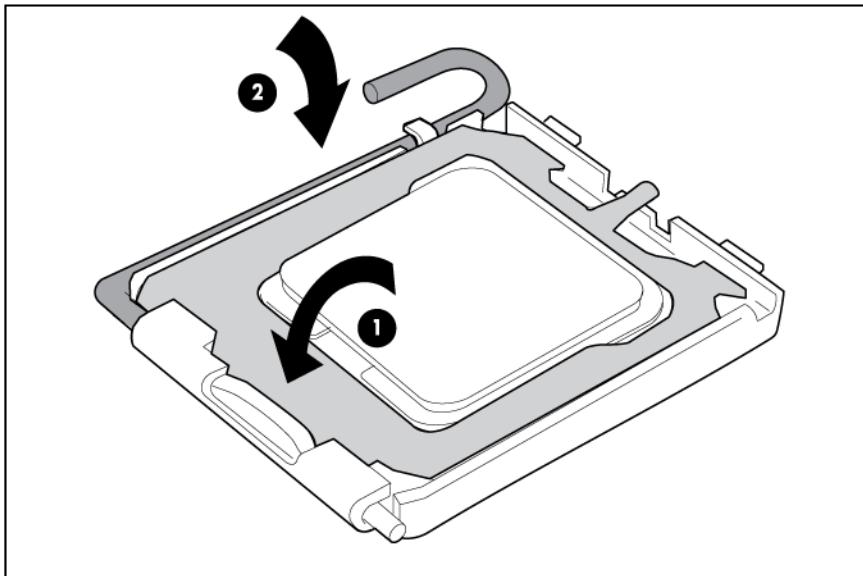


5. Close the processor retaining bracket and the processor retaining latch.

⚠ **CAUTION:** Be sure to close the processor socket retaining bracket before closing the processor locking lever. The lever should close without resistance. Forcing the lever closed can damage the processor and socket, requiring system board replacement.

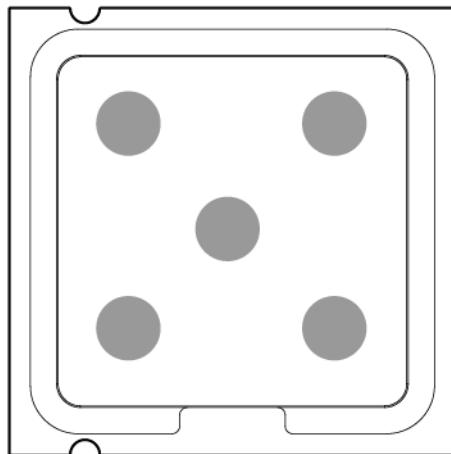
⚠ **CAUTION:** To avoid damage to the system board:

- Do not touch the processor socket contacts.
- Always install the processor socket cover after removing the processor from the socket.
- Do not tilt or slide the processor when lowering the processor into the socket.

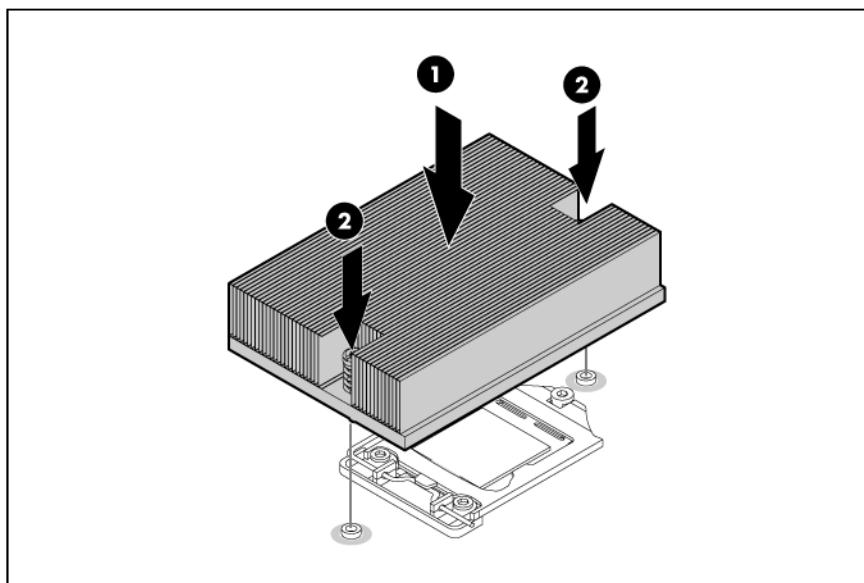


6. Clean the old thermal grease from the processor and the bottom of the heatsink with the alcohol swab. Allow the alcohol to evaporate before continuing.

7. Apply all the grease to the top of the processor in the following pattern to ensure even distribution.



8. Install the heatsink, and then insert and tighten the two screws.



**IMPORTANT:** Install all components with the same configuration that was used on the failed system board.

9. Install all components and cables removed from the failed system board.
10. Install the air baffle.
11. Install the access panel.
12. Install the power supplies.
13. Power on the server.

After you replace the system board, you must re-enter the server serial number and the product ID.

1. During the server startup sequence, press the **F9** key to access RBSU.
2. Select the **Advanced Options** menu.
3. Select **Service Options**.
4. Select **Serial Number**. The following warnings appear:

WARNING! WARNING! WARNING! The serial number is loaded into the system during the manufacturing process and should NOT be modified. This option should only be used by qualified service personnel. This value should always match the serial number sticker located on the chassis.

Warning: The serial number should ONLY be modified by qualified personnel. This value should always match the serial number located on the chassis.

5. Press the **Enter** key to clear the warning.
6. Enter the serial number and press the **Enter** key.
7. Select **Product ID**. The following warning appears:  
Warning: The Product ID should ONLY be modified by qualified personnel. This value should always match the Product ID on the chassis.
8. Enter the product ID and press the **Enter** key.
9. Press the **Esc** key to close the menu.
10. Press the **Esc** key to exit RBSU.
11. Press the **F10** key to confirm exiting RBSU. The server automatically reboots.

# Cabling

## Cabling overview

This section provides guidelines that help you make informed decisions about cabling the server and hardware options to optimize performance.

### Server cabling

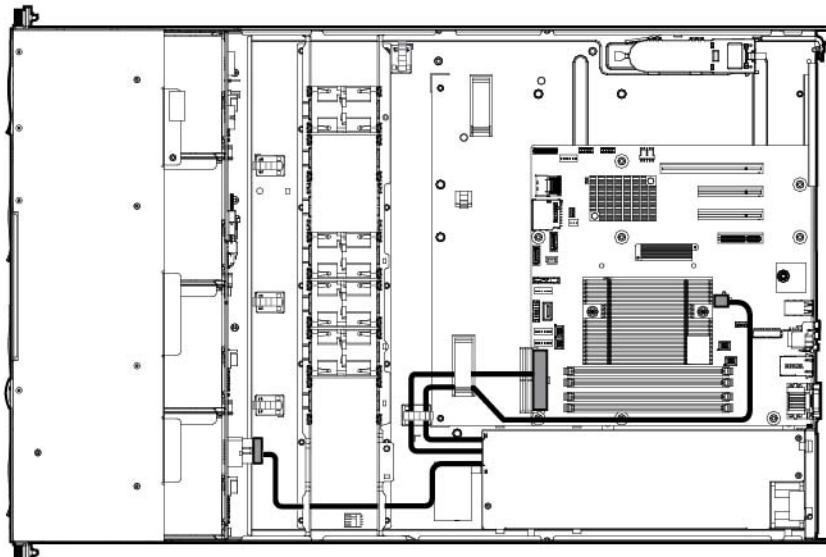


**CAUTION:** When routing cables, always be sure that the cables are not in a position where they can be pinched or air flow can be blocked.

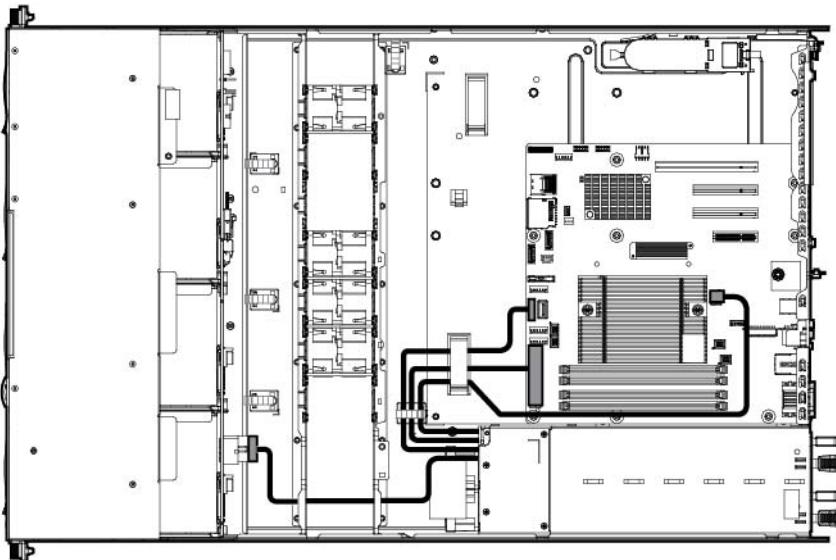


**IMPORTANT:** Route the cables without blocking the airflow or other installed components. Use the cable clips installed in the chassis to manage cable routing.

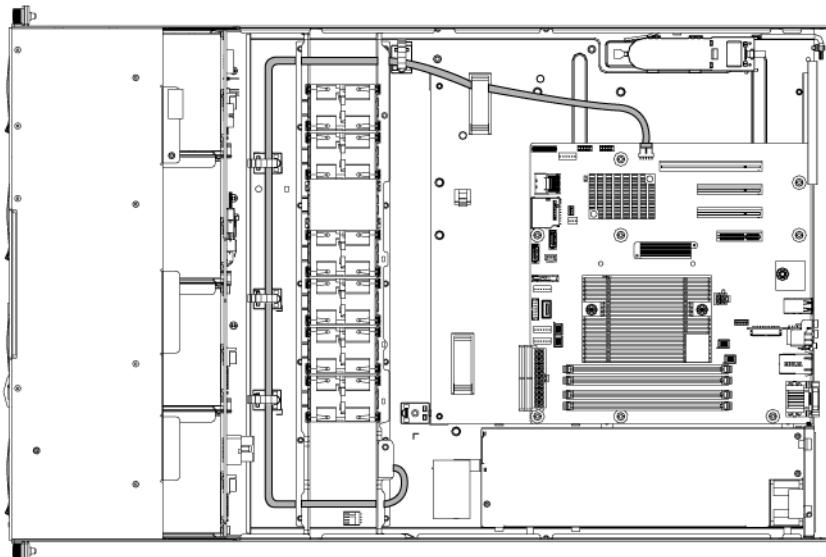
### Nonredundant power supply cabling



## Redundant power supply cabling

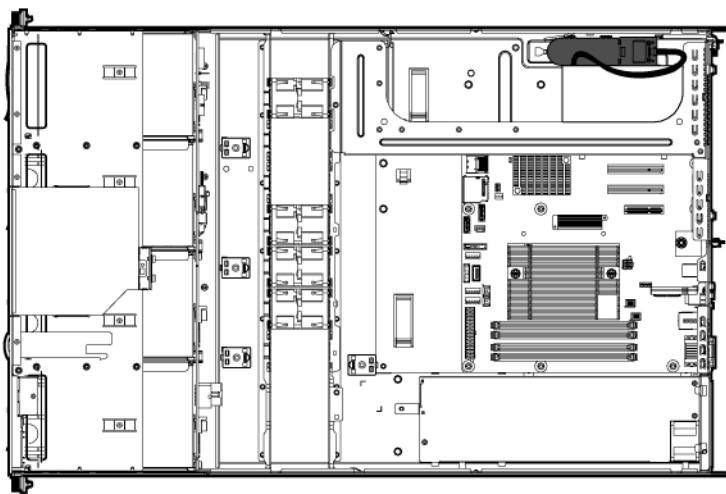


## Internal USB cabling

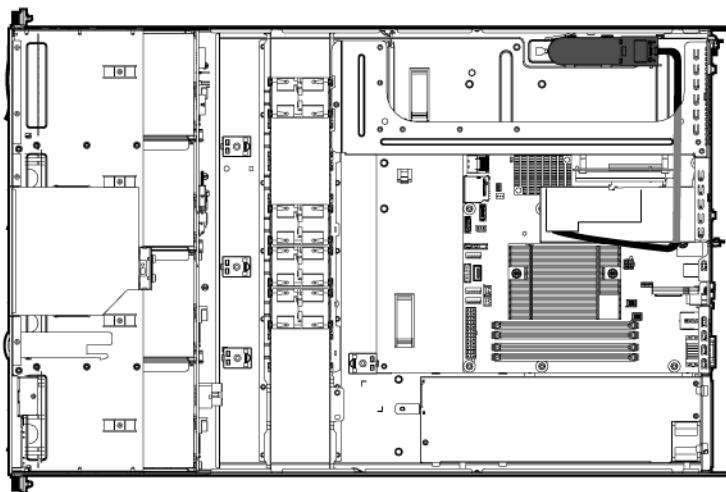


## BBWC battery cabling

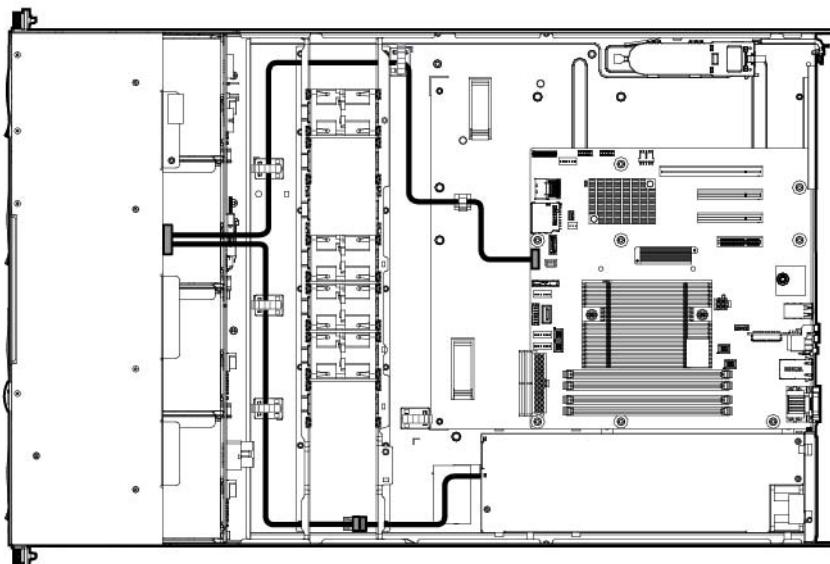
- Smart Array controller installed in full height full length slot



- Smart Array controller installed in low profile slot

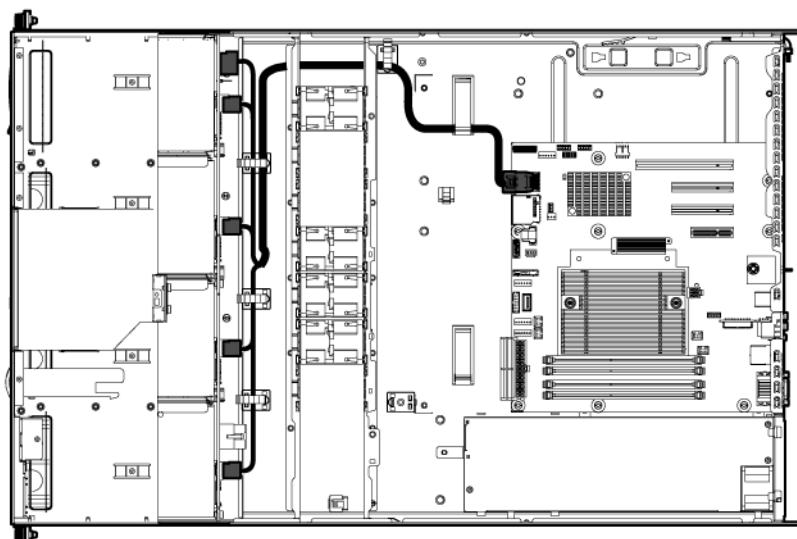


## Optical drive cabling

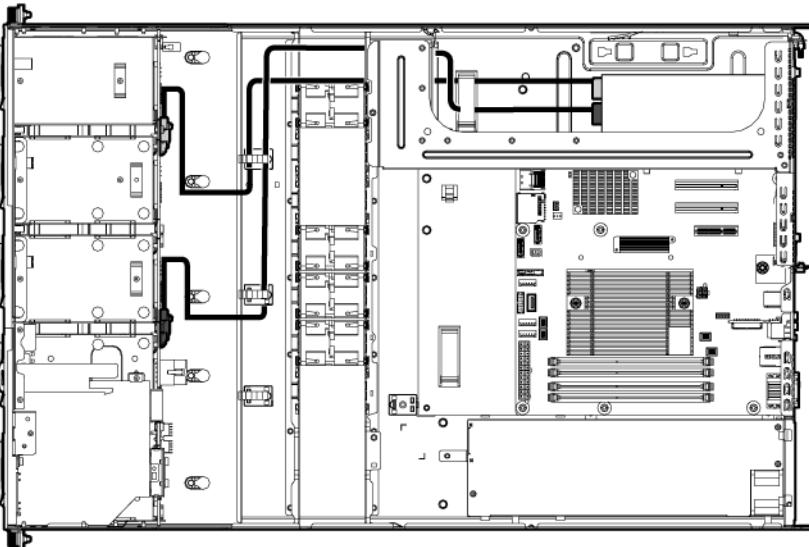


## SATA cabling

- LFF configuration

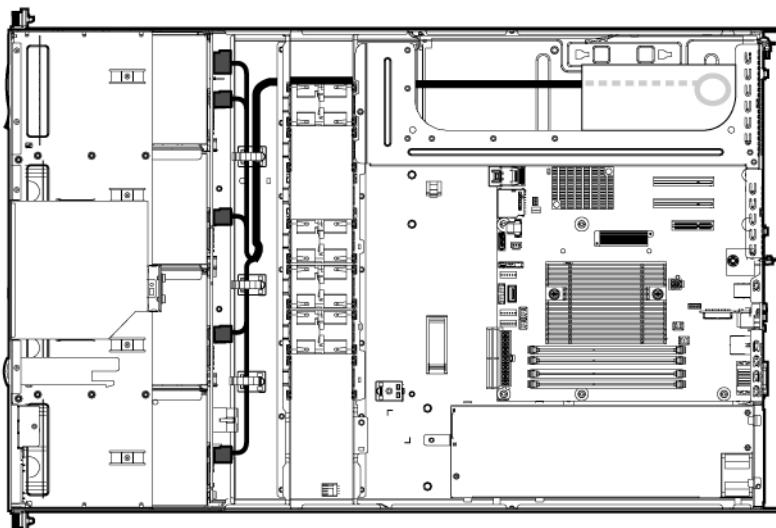


- SFF configuration

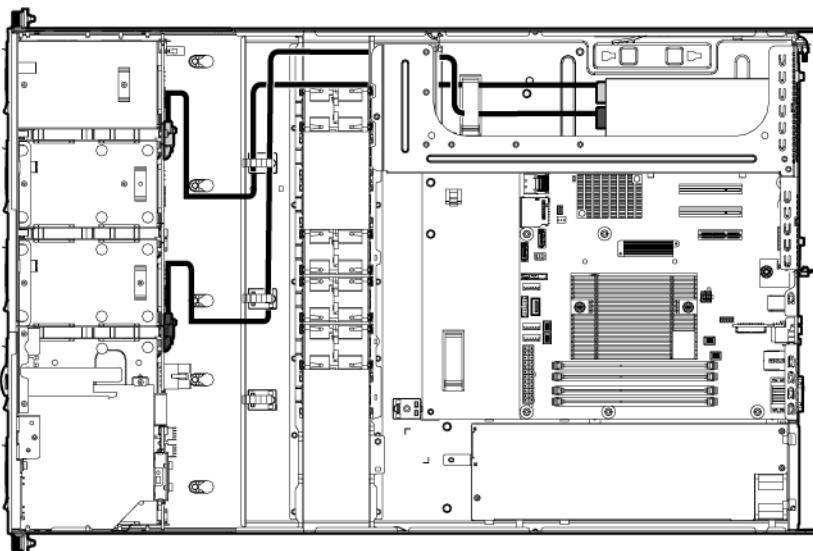


## SAS cabling

- LFF configuration



- SFF configuration



# Diagnostic tools

## HP Insight Diagnostics

HP Insight Diagnostics is a proactive server management tool, available in both offline and online versions, that provides diagnostics and troubleshooting capabilities to assist IT administrators who verify server installations, troubleshoot problems, and perform repair validation.

HP Insight Diagnostics Offline Edition performs various in-depth system and component testing while the OS is not running. To run this utility, launch the SmartStart CD.

HP Insight Diagnostics Online Edition is a web-based application that captures system configuration and other related data needed for effective server management. Available in Microsoft® Windows® and Linux versions, the utility helps to ensure proper system operation.

For more information or to download the utility, refer to the HP website (<http://www.hp.com/servers/diags>).

## Integrated Management Log

The IML records hundreds of events and stores them in an easy-to-view form. The IML timestamps each event with 1-minute granularity.

You can view recorded events in the IML in several ways, including the following:

- From within HP SIM
- From within Survey Utility
- From within operating system-specific IML viewers
  - For NetWare: IML Viewer (does not apply to HP ProLiant DL980 Servers)
  - For Windows®: IML Viewer
  - For Linux: IML Viewer Application
- From within the iLO user interface
- From within HP Insight Diagnostics (on page 61)

For more information, see the Management CD or DVD in the HP Insight Foundation suite for ProLiant.

## HP Insight Remote Support software

HP strongly recommends that you install HP Insight Remote Support software to complete the installation or upgrade of your product and to enable enhanced delivery of your HP Warranty, HP Care Pack Service, or HP contractual support agreement. HP Insight Remote Support supplements your monitoring 24 x 7 to ensure maximum system availability by providing intelligent event diagnosis, and automatic, secure submission of hardware event notifications to HP, which will initiate a fast and accurate resolution, based on your product's service level. Notifications may be sent to your authorized HP Channel Partner for on-site service, if configured and available in your country. The software is available in two variants:

- HP Insight Remote Support Standard: This software supports server and storage devices and is optimized for environments with 1–50 servers. Ideal for customers who can benefit from proactive notification but do not need proactive service delivery and integration with a management platform.
- HP Insight Remote Support Advanced: This software provides comprehensive remote monitoring and proactive service support for nearly all HP servers, storage, network, and SAN environments, plus selected non-HP servers that have a support obligation with HP. It is integrated with HP Systems Insight Manager. A dedicated server is recommended to host both HP Systems Insight Manager and HP Insight Remote Support Advanced.

Details for both versions are available on the HP website (<http://www.hp.com/go/insightremotesupport>).

To download the software, go to Software Depot (<http://www.software.hp.com>).

Select **Insight Remote Support** from the menu on the right.

## USB support

HP provides both standard USB 2.0 support and legacy USB 2.0 support. Standard support is provided by the OS through the appropriate USB device drivers. Before the OS loads, HP provides support for USB devices through legacy USB support, which is enabled by default in the system ROM.

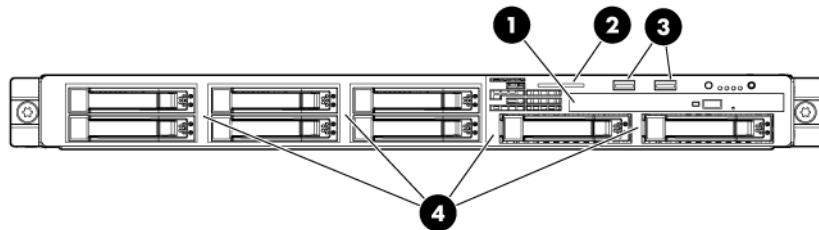
Legacy USB support provides USB functionality in environments where USB support is not available normally. Specifically, HP provides legacy USB functionality for the following:

- POST
- RBSU
- Diagnostics
- DOS
- Operating environments which do not provide native USB support

# Server component identification

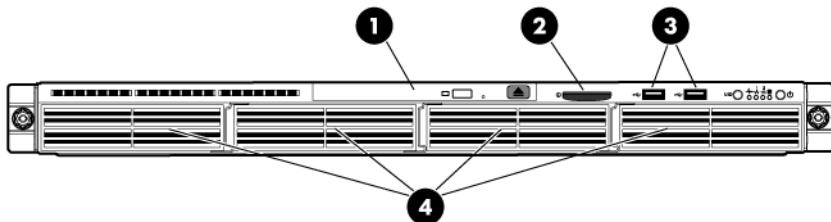
## Front panel components

- SFF configuration



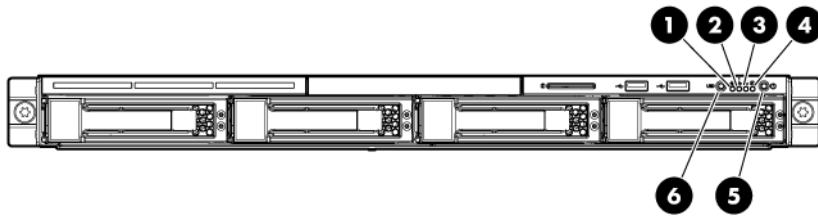
Item	Description
1	Optical drive
2	Serial label pull tab
3	USB connectors (2)
4	Drive bays

- LFF configuration



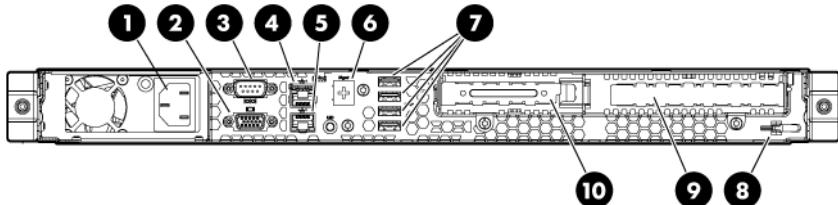
Item	Description
1	Optical drive
2	Serial label pull tab
3	USB connectors (2)
4	Drive bays

## Front panel LEDs



Item	Description	Status
1	Internal health LED	Green = Normal Amber = System degraded Red = System critical Off = Normal (when in standby mode)
2	NIC 1 link/activity LED	Green = Network link Flashing green = Network link and activity Off = No network link If the power is off, view the LEDs on the RJ-45 connector.
3	NIC 2 link/activity LED	Green = Network link Flashing green = Network link and activity Off = No link to network If the power is off, view the LEDs on the RJ-45 connector.
4	Drive activity LED	Green = Drive active Off = No drive activity
5	Power On/Standby button and system power LED	Green = Normal (system on) Amber = System in standby, but power is still applied Off = Power cord not attached or the power supply failed
6	UID button/LED	Blue = Activated Flashing blue = System being managed remotely Off = Deactivated

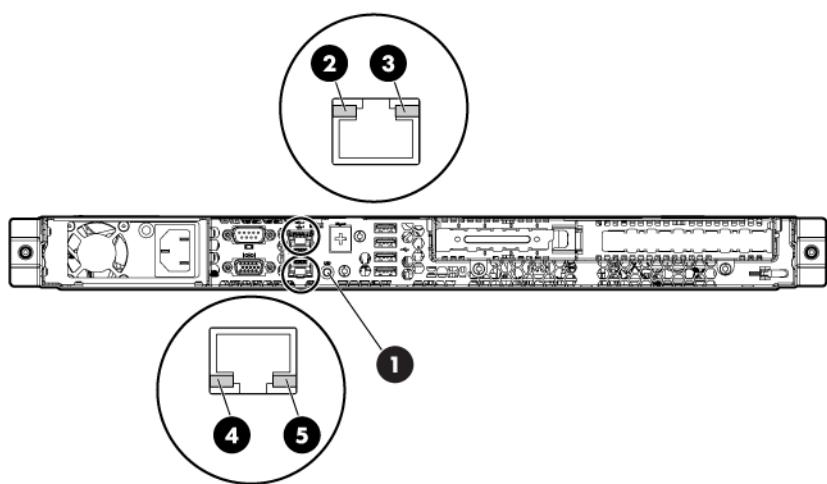
## Rear panel components



Item	Description
1	Power cord connector
2	Video connector
3	Serial connector
4	10/100/1000 NIC 2 connector

<b>Item</b>	<b>Description</b>
5	10/100/1000 NIC 1 connector/ shared iLO management port
6	HP dedicated iLO management port (optional)
7	USB connectors (4)
8	T10/T15 tool
9	Slot 1 PCIe2 x16 (16, 8, 4, 1)
10	Slot 2 PCIe2 x8 (4, 1)

## Rear panel LEDs

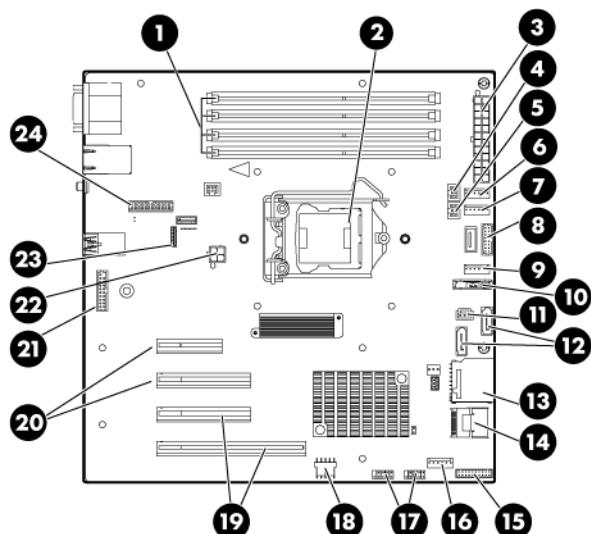


<b>Item</b>	<b>Description</b>	<b>Status</b>
1	UID button/LED	Blue = Identification Flashing blue = System is being managed remotely Off = Off
2	NIC2 link LED	Green = 10M/100M/1G link speed Off = No connection
3	NIC2 activity LED	Green = Linked to the network Flashing green = Linked and activity on the network Off = No network activity
4	NIC1 link LED	Green = 10M/100M/1G link speed Off = No connection
5	NIC1 activity LED	Green = Linked to the network Flashing green = Linked and activity on the network Off = No network activity

# PCIe expansion slot definitions

Slot	Type	Length	Connector	Interconnect
1	PCIe2	Full	x16	x16
2	PCIe2	Half	x8	x4

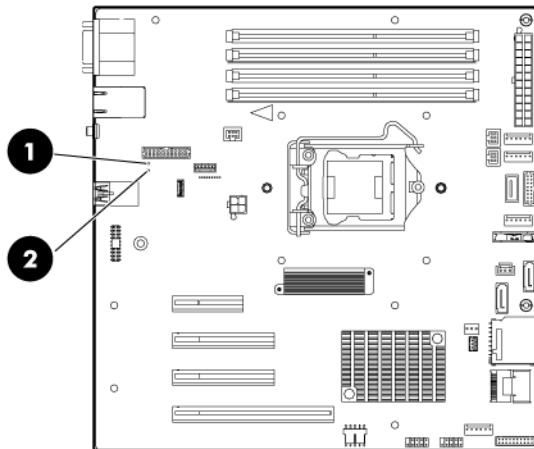
# System board components



Item	Description
1	DIMM slots 1-4
2	Processor socket
3	System power connector (24 pin)
4	Fan connector 7 (Reserved)
5	Fan connector 8 (Reserved)
6	Fan connector 3
7	Fan connector 4
8	RPS connector
9	Fan connector 5
10	System battery
11	I <sup>2</sup> C cable connector
12	SATA connectors
13	SD card slot
14	Mini-SAS connector
15	Front panel connector
16	Fan connector 6
17	Front USB connectors
18	Internal USB connector
19	PCIe riser board connectors
20	Reserved

Item	Description
21	TPM connector
22	Power supply connector (4 pin)
23	System maintenance switch
24	HP dedicated iLO management connector

## System board LEDs



Item	LED description	Status
1	Power supply 1 failure	Red = Power supply 1 failed Off = Normal
2	Power supply 2 (redundant) failure	Red = Power supply 2 failed Off = Normal

## System maintenance switch

Position	Default	Function
1	Off	Off = iLO 3 security is enabled On = iLO 3 security is disabled
2	Off	Off = System configuration can be changed On = System configuration is locked
3	Off	Reserved
4	Off	Reserved
5	Off	Off = Password is enabled On = Password is disabled
6	Off	Off = No function On = Clear NVRAM
7	Off	Reserved

Position	Default	Function
8	Off	Reserved
9	Off	Reserved
10	Off	Reserved

When the system maintenance switch position 6 is set to the On position, the system is prepared to erase all system configuration settings from both CMOS and NVRAM.



**CAUTION:** Clearing CMOS and/or NVRAM deletes configuration information. Be sure to properly configure the server or data loss could occur.

## NMI functionality

An NMI crash dump enables administrators to create crash dump files when a system is hung and not responding to traditional debug mechanisms.

Crash dump log analysis is an essential part of diagnosing reliability issues, such as hangs in operating systems, device drivers, and applications. When crashes freeze a system, administrators must cycle the system power. Resetting the system erases any information that support issue analysis, but the NMI feature preserves that information by performing a memory dump before a hard reset.

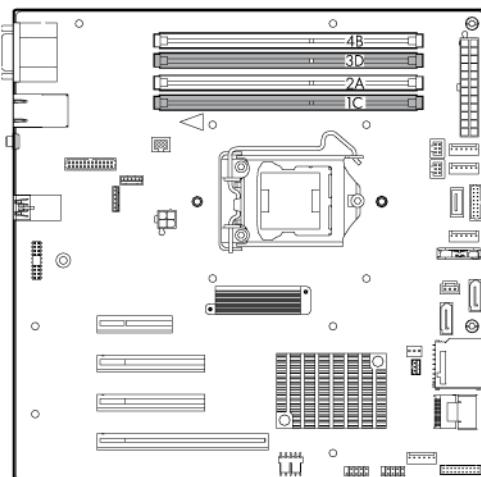
The administrator must use the iLO Virtual NMI feature to force the OS to invoke the NMI handler and generate a crash dump log.

For additional information, see the HP website

(<http://h20000.www2.hp.com/bc/docs/support/SupportManual/c00797875/c00797875.pdf>).

## DIMM slot locations

DIMM slots are numbered sequentially for the processor.



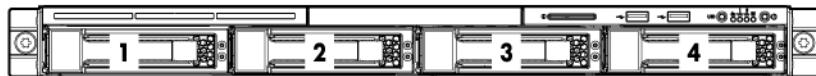
Populate the DIMM slots in the following sequence:

- 1 DIMM: 2A

- 2 DIMMs: 2A+4B
- 3 DIMMs: 2A+4B+1C
- 4 DIMMs: All DIMMs

## SAS and SATA device numbering

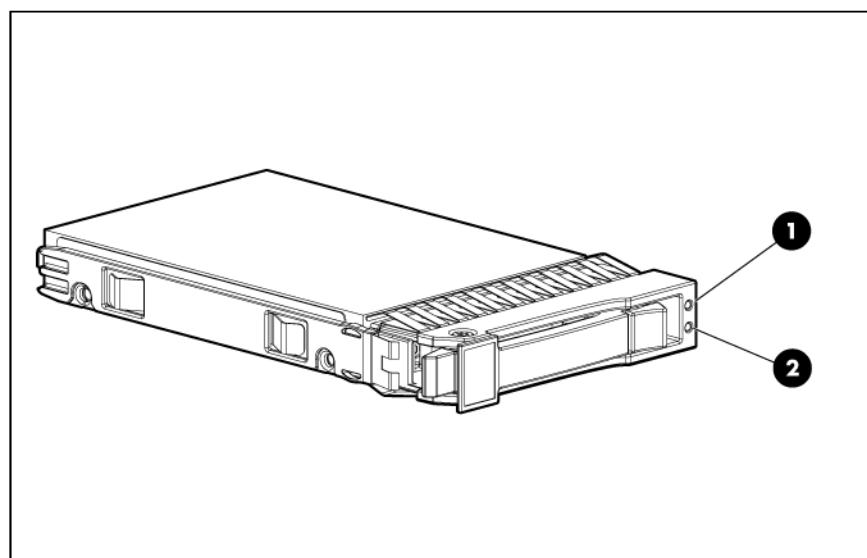
- LFF device bay numbering



- SFF device bay numbering

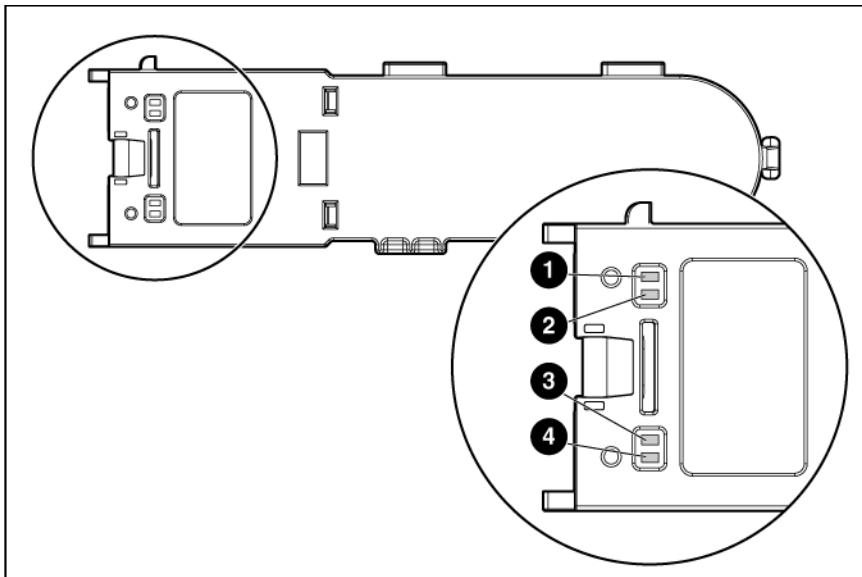


## SAS and SATA hard drive LEDs



Item	Description
1	Fault/UID LED (amber/blue)
2	Online LED (green)

## BBWC module LEDs

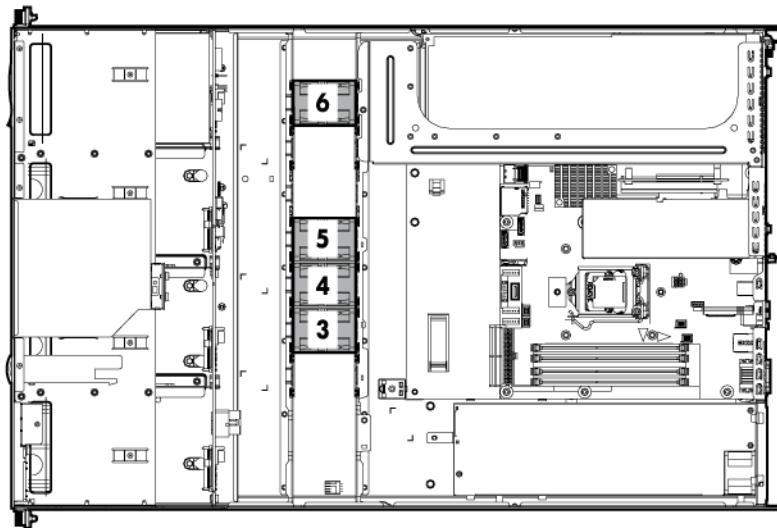


Item ID	Color	Description
1	Green	System Power LED. This LED illuminates steadily when the system is powered up and 12-V system power is available. This power supply is used to maintain the battery charge and provide supplementary power to the cache microcontroller.
2	Green	Auxiliary Power LED. This LED illuminates steadily when 3.3 V auxiliary voltage is detected. The auxiliary voltage is used to preserve BBWC data and is available any time that the system power cords are connected to a power supply.
3	Amber	Battery Health LED. To interpret the illumination patterns of this LED, see the following table.
4	Green	BBWC Status LED. To interpret the illumination patterns of this LED, see the following table.

LED3 pattern	LED4 pattern	Interpretation
—	One flash every two seconds	<p>The system is powered down, and the cache contains data that has not yet been written to the drives. Restore system power as soon as possible to prevent data loss.</p> <p>If 3.3 V auxiliary power is available, as indicated by LED 2, then data preservation time is extended. If no auxiliary power is available, only battery power preserves the data. A fully-charged battery can normally preserve data for at least two days.</p> <p>The battery lifetime also depends on the cache module size. For more information, see the controller QuickSpecs on the HP website (<a href="http://www.hp.com">http://www.hp.com</a>).</p>
—	Double flash, then pause	The cache microcontroller is waiting for the host controller to communicate.

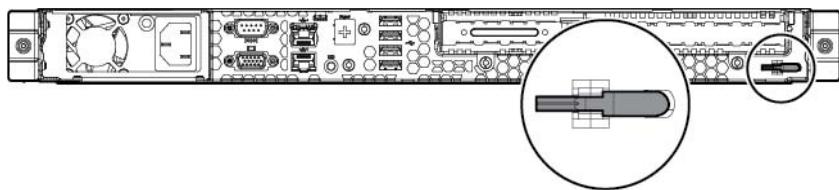
<b>LED3 pattern</b>	<b>LED4 pattern</b>	<b>Interpretation</b>
—	One flash per second	The battery pack is below the minimum charge level and is being charged. Features that require a battery (such as write cache, capacity expansion, stripe size migration, and RAID migration) are temporarily unavailable until charging is complete. The recharge process takes between 15 minutes and 2 hours, depending on the initial capacity of the battery.
—	Steady glow	The battery pack is fully charged, and posted write data is stored in the cache.
—	Off	The battery pack is fully charged, and write data is not posted in the cache.
One flash per second	One flash per second	An alternating green and amber blink pattern indicates that the cache microcontroller is executing from within its boot loader and receiving new flash code from the host controller.
Steady glow	—	There is a short circuit across the battery terminals or within the battery pack. BBWC features are disabled until the battery pack is replaced. The life expectancy of a battery pack is typically more than three years.
One flash per second	—	An open circuit is across the battery terminals or within the battery pack. BBWC features are disabled until the battery pack is replaced. The life expectancy of a battery pack is typically more than three years.

## Fan locations



## T-10/T15 Torx screwdriver

The server includes a T-10/T-15 Torx screwdriver located on the rear panel of the server. Use the screwdriver to loosen screws during hardware configuration procedures.



# Specifications

## Environmental specifications

Specification	Value
<b>Temperature range*</b>	
Operating	10°C to 35°C (50°F to 95°F)
Nonoperating	-30°C to 60°C (-22°F to 140°F)
<b>Relative humidity (noncondensing)</b>	
Operating, maximum wet bulb temperature of 28°C (82.4°F)	10% to 90%
Nonoperating, maximum wet bulb temperature of 38.7°C (101.7°F)	5% to 95%

\* All temperature ratings shown are for sea level. An altitude derating of 1°C per 304.8 m (1.8°F per 1,000 ft) to 3048 m (10,000 ft) is applicable. No direct sunlight allowed.

## Mechanical specifications

Specification	Value
<b>Dimensions</b>	
Height	4.44 cm (1.75 in)
Depth	70 cm (27.56 in)
Width	44.8 cm (17.64 in)
Weight (maximum)	14.26 kg (31.4 lb)
Weight (one hard drive installed))	10.37 kg (22.84 lb)

## Power supply specifications

Depending on installed options, the server is configured with one of the following power supplies.

- HP ProLiant 400-W nonredundant power supply assembly

Specification	Value
<b>Input requirements</b>	
Rated input voltage	100 to 240 VAC
Rated input frequency	47 Hz to 63 Hz
Rated input current	Limit at 6 A
Rated input power	570-W at 115 VAC
<b>Power supply output</b>	

Efficiency	Not less than 70% at 100%load Not less than 70% at 50%load Not less than 70% at 20%load
Rated output power	400-W

- HP ProLiant 400-W redundant hot-plug power supply module

Specification	Value
<b>Input requirements</b>	
Rated input voltage	100 to 127 VAC, 200 to 240 VAC
Rated input frequency	47 Hz to 63 Hz
Rated input current	6 A at 100 VAC 3 A at 200 VAC
Rated input power	570-W at 230 VAC
<b>Power supply output</b>	
Efficiency	Not less than 85% at 100% load Not less than 89% at 50% load Not less than 85% at 20% load
Rated output power	400-W

## Hot-plug power supply calculations

For hot-plug power supply specifications and calculators to determine electrical and heat loading for the server, refer to the HP Enterprise Configurator website (<http://h30099.www3.hp.com/configurator/>).

# Support and other resources

## Before you contact HP

Be sure to have the following information available before you call HP:

- Active Health System log  
Download and have available an Active Health System log for 3 days before the failure was detected. For more information, see the *HP iLO 4 User Guide* or *HP Intelligent Provisioning User Guide* on the HP website (<http://www.hp.com/go/ilo/docs>).
- Onboard Administrator SHOW ALL report (for HP BladeSystem products only)  
For more information on obtaining the Onboard Administrator SHOW ALL report, see the HP website (<http://h20000.www2.hp.com/bizsupport/TechSupport/Document.jsp?lang=en&cc=us&objectID=c02843807>).
- Technical support registration number (if applicable)
- Product serial number
- Product model name and number
- Product identification number
- Applicable error messages
- Add-on boards or hardware
- Third-party hardware or software
- Operating system type and revision level

## HP contact information

For United States and worldwide contact information, see the Contact HP website (<http://www.hp.com/go/assistance>).

In the United States:

- To contact HP by phone, call 1-800-334-5144. For continuous quality improvement, calls may be recorded or monitored.
- If you have purchased a Care Pack (service upgrade), see the Support & Drivers website (<http://www8.hp.com/us/en/support-drivers.html>). If the problem cannot be resolved at the website, call 1-800-633-3600. For more information about Care Packs, see the HP website (<http://pro-aq-sama.houston.hp.com/services/cache/10950-0-0-225-121.html>).

---

# Acronyms and abbreviations

## BBWC

battery-backed write cache

## iLO

Integrated Lights-Out

## IML

Integrated Management Log

## NMI

nonmaskable interrupt

## NVRAM

nonvolatile memory

## PCIe

peripheral component interconnect express

## POST

Power-On Self Test

## RBSU

ROM-Based Setup Utility

## RPS

redundant power supply

## SAS

serial attached SCSI

## SATA

serial ATA

## TPM

Trusted Platform Module

**UID**

unit identification

**USB**

universal serial bus

---

## Documentation feedback

HP is committed to providing documentation that meets your needs. To help us improve the documentation, send any errors, suggestions, or comments to Documentation Feedback (<mailto:docsfeedback@hp.com>). Include the document title and part number, version number, or the URL when submitting your feedback.

# Index

## A

AC power supply 29  
access panel 25  
air baffle 25  
authorized reseller 75

## B

battery-backed write cache (BBWC) 37, 39  
Battery-backed write cache LEDs 70  
BBWC cabling 57  
buttons 63

## C

cabling 55, 56, 58  
cautions 23  
components 15, 23, 41, 63  
components, identification 15, 63  
components, system board 67, 68  
connectors 63  
contacting HP 75  
customer self repair (CSR) 5, 75

## D

diagnostic tools 61  
diagnostics utility 61  
DIMMs 47, 68  
drive blank 28  
drive LEDs 69  
DVD-ROM drive 33

## E

electrostatic discharge 23  
environmental specifications 73  
expansion boards 35

## F

fans 35, 71  
features 63  
front panel components 63  
front panel LEDs 64

## H

hard drive LEDs 69  
help resources 75  
hot-plug drive 28  
HP Insight Diagnostics 61  
HP Insight Remote Support software 61  
HP technical support 75

## I

illustrated parts catalog 15  
IML (Integrated Management Log) 61  
Integrated Management Log (IML) 61

## L

LEDs 63, 69  
LEDs, hard drive 69  
LFF drive cage 36

## M

management tools 61  
mechanical components 15  
mechanical specifications 73

## N

NMI header 68  
non-redundant power 31, 32  
nonredundant power supply cabling 55

## O

optical drive 33  
optical drive cable 58

## P

part numbers 15  
PCI expansion slots 66  
PCle riser board 27  
PCle riser cage 26  
phone numbers 75  
power supply specifications 73, 74

powering down 24  
preparation procedures 24

## R

rear panel components 64  
rear panel LEDs 65  
redundant power supply 29, 30  
redundant power supply cabling 56  
removal and replacement procedures 23  
Removing a heatsink 41  
removing server from rack 24  
removing the access panel 25  
removing the battery pack 38  
Removing the processor 43  
removing the system board 48  
required information 75

## S

safety considerations 23  
SAS and SATA device numbers 69  
SAS cabling 59  
SAS hard drive LEDs 69  
SATA cabling 58  
server cabling 55  
specifications 73  
specifications, environmental 73  
specifications, server 73  
static electricity 23  
support and other resources 75  
system battery 40  
system board components 66  
system board LEDs 67  
system components 18  
system maintenance switch 67

## T

T-10 Torx screwdriver 72  
telephone numbers 75  
tools 23  
Trusted Platform Module (TPM) 41

## U

USB support 62  
utilities 61

## W

warnings 23  
website, HP 75